# 16-bit Proprietary Microcontrollers

## F<sup>2</sup>MC-16LX MB90385 Series

## MB90387/387S/F387/F387S/MB90V495G

### ■ DESCRIPTION

MB90385 series devices are general-purpose high-performance 16-bit micro controllers designed for process control of consumer products, which require high-speed real-time processing. The devices of this series have the built-in full-CAN interface.

The system, inheriting the architecture of  $F^2MC^*$  family, employs additional instruction ready for high-level languages, expanded addressing mode, enhanced multiply-divide instructions, and enriched bit-processing instructions. Furthermore, employment of 32-bit accumulator achieves processing of long-word data (32 bits).

The peripheral resources of MB90385 series include the following:

8/10-bit A/D converter, UART (SCI), 8/16-bit PPG timer, 16-bit input-output timer (16-bit free-run timer, input capture 0, 1, 2, 3 (ICU)), and CAN controller.

\*: F<sup>2</sup>MC is the abbreviation of FUJITSU Flexible Microcontroller.

### **■ FEATURES**

#### Clock

- · Built-in PLL clock frequency multiplication circuit
- Selection of machine clocks (PLL clocks) is allowed among frequency division by two on oscillation clock, and multiplication of 1 to 4 times of oscillation clock (for 4-MHz oscillation clock, 4 MHz to 16 MHz).
- Operation by sub-clock (8.192 kHz) is allowed. (MB90387, MB90F387)
- Minimum execution time of instruction: 62.5 ns (when operating with 4-MHz oscillation clock, and 4-time multiplied PLL clock).

(Continued)

For the information for microcontroller supports, see the following web site.

http://edevice.fujitsu.com/micom/en-support/



### • 16 Mbyte CPU memory space

· 24-bit internal addressing

### • Instruction system best suited to controller

- Wide choice of data types (bit, byte, word, and long word)
- Wide choice of addressing modes (23 types)
- Enhanced multiply-divide instructions and RETI instructions
- Enhanced high-precision computing with 32-bit accumulator

### • Instruction system compatible with high-level language (C language) and multitask

- · Employing system stack pointer
- Enhanced various pointer indirect instructions
- · Barrel shift instructions

### Increased processing speed

· 4-byte instruction queue

### • Powerful interrupt function with 8 levels and 34 factors

### • Automatic data transfer function independent of CPU

• Expanded intelligent I/O service function (EI2 OS): Maximum of 16 channels

### • Low power consumption (standby) mode

- Sleep mode (a mode that halts CPU operating clock)
- Time-base timer mode (a mode that operates oscillation clock, sub clock, time-base timer and watch timer only)
- Watch mode (a mode that operates sub clock and watch timer only)
- Stop mode (a mode that stops oscillation clock and sub clock)
- CPU blocking operation mode

### Process

CMOS technology

### • I/O port

• General-purpose input/output port (CMOS output) :

MB90387, MB90F387 : 34 ports (including 4 high-current output ports) MB90387S, MB90F387S : 36 ports (including 4 high-current output ports)

#### • Timer

- Time-base timer, watch timer, watchdog timer: 1 channel
- 8/16-bit PPG timer: 8-bit x 4 channels, or 16-bit x 2 channels
- 16-bit reload timer: 2 channels
- 16-bit input/output timer
  - 16-bit free run timer: 1 channel
  - 16-bit input capture: (ICU): 4 channels

Interrupt request is issued upon latching a count value of 16-bit free run timer by detection of an edge on pin input.

### • CAN controller: 1 channel

- Compliant with Ver2.0A and Ver2.0B CAN specifications
- 8 built-in message buffers
- Transmission rate of 10 kbps to 1 Mbps (by 16 MHz machine clock)
- CAN wake-up

#### • UART (SCI): 1 channel

- Equipped with full-duplex double buffer
- Clock-asynchronous or clock-synchronous serial transmission is available.

### (Continued)

### • DTP/External interrupt: 4 channels, CAN wakeup: 1channel

• Module for activation of expanded intelligent I/O service (El<sup>2</sup>OS), and generation of external interrupt.

### • Delay interrupt generator module

• Generates interrupt request for task switching.

### • 8/10-bit A/D converter: 8 channels

- Resolution is selectable between 8-bit and 10-bit.
- Activation by external trigger input is allowed.
- Conversion time: 6.125 μs (at 16 MHz machine clock, including sampling time)

### • Program patch function

• Address matching detection for 2 address pointers.

### **■ PRODUCT LINEUP**

	Part Number	MB90F387	MB90387	MB90V495G		
Parameter		MB90F387S	MB90387S	WB304-30G		
Classification		Flash ROM Mask ROM		Evaluation product		
ROM capacity		64 Kbyt	tes	_		
RAM capacity		2 Kbyte	es	6 Kbytes		
Process			CMOS			
Package		LQFP-48 (pin pite	ch 0.50 mm)	PGA-256		
Operating power	er supply voltage	3.5 V to 5	5.5 V	4.5 V to 5.5 V		
Special power semulator*1	supply for	_		None		
CPU functions		Instruction bit length Instruction length Data bit length	Instruction length : 1 byte to 7 bytes Data bit length : 1 bit, 8 bits, 16 bits  Minimum instruction execution time : 62.5 ns (at 16 MHz machine clock)			
Low power con (standby) mod		Sleep mode / Watch mode / Time-base timer mode / Stop mode / CPU intermittent				
I/O port		General-purpose input/output ports (CMOS output): 34 ports (36 ports*2) including 4 high-current output ports (P14 to P17)				
Time-base time	er	18-bit free-run counter Interrupt cycle: 1.024 ms, 4.096 ms, 16.834 ms, 131.072 ms (with oscillation clock frequency at 4 MHz)				
Watchdog time	r	Reset generation cycle: 3.58 ms, 14.33 ms, 57.23 ms, 458.75 ms (with oscillation clock frequency at 4 MHz)				
16-bit input/	16-bit free-run timer	Number of channels: 1 Interrupt upon occurrence of	overflow			
output timer	Input capture	Number of channels: 4 Retaining free-run timer value set by pin input (rising edge, falling edge, and both edges)				
16-bit reload timer		Number of channels: 2 16-bit reload timer operation Count clock cycle: 0.25 μs, 0.5 μs, 2.0 μs (at 16-MHz machine clock frequency) External event count is allowed.				
Watch timer		15-bit free-run counter Interrupt cycle: 31.25 ms, 62.5 ms, 12 ms, 250 ms, 500 ms, 1.0 s, 2.0 s (with 8.192 kHz sub clock)				
8/16-bit PPG timer		Number of channels: 2 (four 8-bit channels are available also.) PPG operation is allowed with four 8-bit channels or two 16-bit channels. Outputting pulse wave of arbitrary cycle or arbitrary duty is allowed. Count clock: 62.5 ns to 1 µs (with 16 MHz machine clock)				

### (Continued)

Part Number Parameter	MB90F387 MB90F387S	MB90387 MB90387S	MB90V495G	
Delay interrupt generator module	Interrupt generator modul	e for task switching. Used	for realtime OS.	
DTP/External interrupt		falling edge, "H" level or "L nded intelligent I/O service		
8/10-bit A/D converter	Number of channels: 8 Resolution: Selectable 10-bit or 8-bit. Conversion time: 6.125 µs (at 16 MHz machine clock, including sampling time) Sequential conversion of two or more successive channels is allowed. (Setting a maximum of 8 channels is allowed.) Single conversion mode : Selected channel is converted only once. Sequential conversion mode: Selected channel is converted repetitively. Halt conversion mode : Conversion of selected channel is stopped and activated alternately.			
UART(SCI)	Number of channels: 1 Clock-synchronous transfer: 62.5 kbps to 2 Mbps Clock-asynchronous transfer: 9,615 bps to 500 kbps Communication is allowed by bi-directional serial communication function and master/slave type connection.			
CAN	Compliant with Ver 2.0A and Ver 2.0B CAN specifications. 8 built-in message buffers. Transmission rate of 10 kbps to 1 Mbps (by 16 MHz machine clock) CAN wake-up			

<sup>\*1 :</sup> Settings of DIP switch S2 for using emulation pod MB2145-507. For details, see MB2145-507 Hardware Manual (2.7 Power Pin solely for Emulator).

### ■ PACKAGES AND PRODUCT MODELS

Package	MB90F387, MB90F387S	MB90387, MB90387S	
FPT-48P-M26	$\circ$	$\circ$	

 $\bigcirc$ : Yes  $\times$ : No

Note: Refer to "■ PACKAGE DIMENSION" for details of the package.

### **■ PRODUCT COMPARISON**

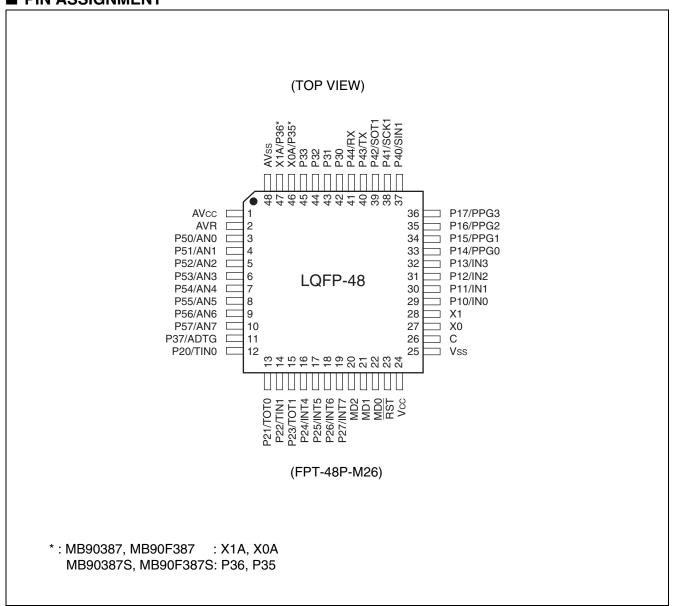
#### **Memory space**

When testing with test product for evaluation, check the differences between the product and a product to be used actually. Pay attention to the following points:

- The MB90V495G has no built-in ROM. However, a special-purpose development tool allows the operations as those of one with built-in ROM. ROM capacity depends on settings on a development tool.
- On MB90V495G, an image from FF4000<sub>H</sub> to FFFFFF<sub>H</sub> is viewed on 00 bank and an image of FE0000<sub>H</sub> to FF3FFF<sub>H</sub> is viewed only on FE bank and FF bank. (Modified on settings of a development tool.)
- On MB90F387/F387S/387S, an image from FF4000<sub>H</sub> to FFFFFF<sub>H</sub> is viewed on 00 bank and an image of FE0000<sub>H</sub> to FF3FFF<sub>H</sub> is viewed only on FF bank.

<sup>\*2:</sup> MB90387S, MB90F387S

### **■ PIN ASSIGNMENT**



### **■ PIN DESCRIPTION**

Pin No.	Pin name	Circuit type	Function
1	AVcc	_	Vcc power input pin for A/D converter.
2	AVR	_	Power (Vref+) input pin for A/D converter. Use as input for Vcc or lower.
	P50 to P57		General-purpose input/output ports.
3 to 10	AN0 to AN7	E	Functions as analog input pins for A/D converter. Valid when analog input setting is "enabled."
	P37		General-purpose input/output port.
11	ADTG	D	Function as an external trigger input pin for A/D converter. Use the pin by setting as input port.
	P20		General-purpose input/output port.
12	TIN0	D	Function as an event input pin for reload timer 0. Use the pin by setting as input port.
	P21		General-purpose input/output port.
13	ТОТ0	D	Function as an event output pin for reload timer 0. Valid only when output setting is "enabled."
	P22		General-purpose input/output port.
14	TIN1	D	Function as an event input pin for reload timer 1. Use the pin by setting as input port.
P23			General-purpose input/output port.
15	TOT1	D	Function as an event output pin for reload timer 1. Valid only when output setting is "enabled."
16 to 19	P24 to P27	D	General-purpose input/output ports.
10 10 19	INT4 to INT7	D	Functions as external interrupt input pins. Use the pins by setting as input port.
20	MD2	F	Input pin for specifying operation mode. Connect directly to Vss.
21	MD1	С	Input pin for specifying operation mode. Connect directly to Vcc.
22	MD0	С	Input pin for specifying operation mode. Connect directly to Vcc.
23	RST	В	External reset input pin.
24	Vcc		Power source (5 V) input pin.
25	Vss	_	Power source (0 V) input pin.
26	С	_	Capacitor pin for stabilizing power source. Connect a ceramic capacitor of approximately 0.1 $\ensuremath{\mu F}\xspace$ .
27	X0	А	Pin for high-rate oscillation.
28	X1	Α	Pin for high-rate oscillation.
	P10 to P13		General-purpose input/output ports.
29 to 32	IN0 to IN3	D	Functions as trigger input pins of input capture ch.0 to ch.3. Use the pins by setting as input ports.

Pin No.	Pin name	Circuit type	Function	
	P14 to P17		General-purpose input/output ports. High-current output ports.	
33 to 36	PPG0 to PPG3	G	Functions as output pins of PPG timers 01 and 23. Valid when output setting is "enabled."	
37	P40	D	General-purpose input/output port.	
31	SIN1	U	Serial data input pin for UART. Use the pin by setting as input port.	
	P41		General-purpose input/output port.	
38	SCK1	D	Serial clock input pin for UART. Valid only when serial clock input/output setting on UART is "enabled."	
	P42		General-purpose input/output port.	
39	SOT1	D	Serial data input pin for UART. Valid only when serial data input/output setting on UART is "enabled."	
	P43		General-purpose input/output port.	
40	TX	D	Transmission output pin for CAN. Valid only when output setting is "enabled."	
	P44		General-purpose input/output port.	
41	RX	D	Transmission output pin for CAN. Valid only when output setting is "enabled."	
42 to 45	P30 to P33	D	General-purpose input/output ports.	
46	X0A*	Α	Pin for low-rate oscillation.	
40	P35*	Α	General-purpose input/output port.	
47	X1A*	Α	Pin for low-rate oscillation.	
41	P36*	Α	General-purpose input/output port.	
48	AVss	_	Vss power source input pin for A/D converter.	

<sup>\*:</sup> MB90387, MB90F387 : X1A, X0A MB90387S, MB90F387S: P36, P35

### ■ I/O CIRCUIT TYPE

Туре	Circuit	Remarks
А	X1 X1A X0 X0A Standby control signal	<ul> <li>High-rate oscillation feedback resistor, approx.1 MΩ</li> <li>Low-rate oscillation feedback resistor, approx.10 MΩ</li> </ul>
В	R N Nysteresis input	<ul> <li>Hysteresis input with pull-up resistor.</li> <li>Pull-up resistor, approx.50 kΩ</li> </ul>
С	R	Hysteresis input
D	Vcc  P-ch Digital output  N-ch Digital output  N-ch Digital output  N-ch Digital output  Standby control	<ul> <li>CMOS hysteresis input</li> <li>CMOS level output</li> <li>Standby control provided</li> </ul>
E	P-ch Digital output  N-ch Digital output  N-ch Digital output  N-ch Digital output  Standby control  Analog input	CMOS hysteresis input CMOS level output Shared for analog input pin Standby control provided

Type	Circuit	Remarks
F	R W → Hysteresis input	<ul> <li>Hysteresis input with pull-down resistor</li> <li>Pull-down resistor, approx. 50 kΩ</li> <li>Flash product is not provided with pull-down resistor.</li> </ul>
G	P-ch High-current output  High-current output  N-ch  Vss  CMOS  hysteresis input  Standby control	CMOS hysteresis input CMOS level output (high-current output) Standby control provided

### **■ HANDLING DEVICES**

### • Do Not Exceed Maximum Rating (preventing "latch up")

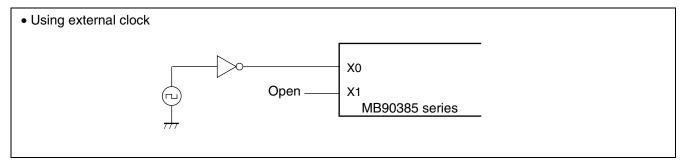
- On a CMOS IC, latch-up may occur when applying a voltage higher than Vcc or a voltage lower than Vss to input or output pin, which has no middle or high withstand voltage. Latch-up may also occur when a voltage exceeding maximum rating is applied across Vcc pin and Vss pin.
- Latch-up causes drastic increase of power current, which may lead to destruction of elements by heat. Extreme caution must be taken not to exceed maximum rating.
- When turning on and off analog power source, take extra care not to apply an analog power voltages (AVcc and AVR) and analog input voltage that are higher than digital power voltage (Vcc).

### Handling Unused Pins

• Leaving unused input pins open may cause permanent destruction by malfunction or latch-up. Apply pull-up or pull-down process to the unused pins using resistors of 2 k $\Omega$  or higher. Leave unused input/output pins open under output status, or process as input pins if they are under input status.

### Using External Clock

 When using an external clock, drive only X0 pin and leave X1 pin open. An example of using an external clock is shown below.



### Notes When Using No Sub Clock

• If an oscillator is not connected to X0A and X1A pin, apply pull-down resistor to X0A pin and leave X1A pin open.

#### About Power Supply Pins

- If two or more Vcc and Vss pins exist, the pins that should be at the same potential are connected to each other inside the device. For reducing unwanted emissions and preventing malfunction of strobe signals caused by increase of ground level, however, be sure to connect the Vcc and Vss pins to the power source and the ground externally.
- Pay attention to connect a power supply to Vcc and Vss of MB90385 series device in a lowest-possible impedance.
- Near pins of MB90385 series device, connecting a bypass capacitor is recommended at 0.1  $\mu F$  across Vcc pin and Vss pin.

#### • Crystal Oscillator Circuit

- Noises around X0 and X1 pins cause malfunctions on a MB90385 series device. Design a print circuit so that X0 and X1 pins, an crystal oscillator (or a ceramic oscillator), and bypass capacitor to the ground become as close as possible to each other. Furthermore, avoid wires to X0 and X1 pins crossing each other as much as possible.
- Print circuit designing that surrounds X0 and X1 pins with grounding wires, which ensures stable operation, is strongly recommended.

#### • Caution on Operations during PLL Clock Mode

• If the PLL clock mode is selected, the microcontroller attempt to be working with the self-oscillating circuit even when there is no external oscillator or external clock input is stopped. Performance of this operation, however, cannot be guaranteed.

### • Sequence of Turning on Power of A/D Converter and Applying Analog Input

- Be sure to turn on digital power (Vcc) before applying signals to the A/D converter and applying analog input signals (AN0 to AN7 pins).
- Be sure to turn off the power of A/D converter and analog input before turning off the digital power source.
- Be sure not to apply AVR exceeding AVcc when turning on and off. (No problems occur if analog and digital power is turned on and off simultaneously.)

### • Handling Pins When A/D Converter is Not Used

• If the A/D converter is not used, connect the pins under the following conditions: "AVcc=AVR=Vcc," and "AVss=Vss"

### • Note on Turning on Power

• For preventing malfunctions on built-in step-down circuit, maintain a minimum of 50 μs of voltage rising time (between 0.2 V and 2.7V) when turning on the power.

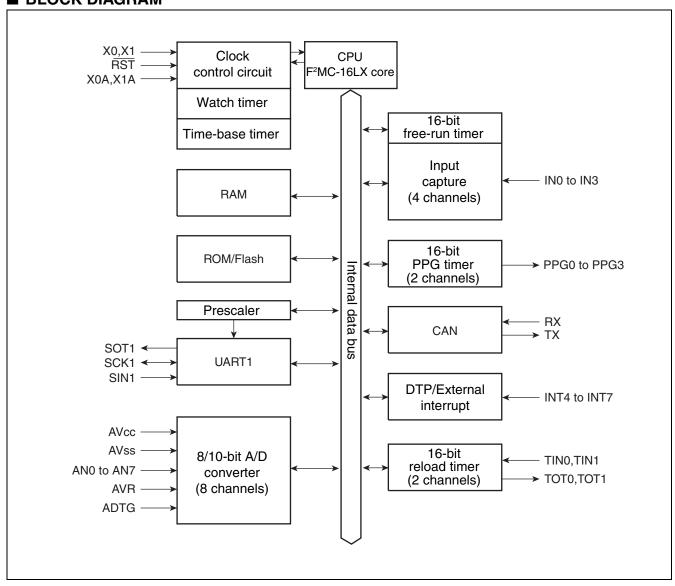
### Stabilization of supply voltage

• A sudden change in the supply voltage may cause the device to malfunction even within the specified Vcc supply voltage operating range. Therefore, the Vcc supply voltage should be stabilized.

For reference, the supply voltage should be controlled so that Vcc ripple variations (peak-to-peak values) at

commercial frequencies (50 Hz / 60 Hz) fall below 10% of the standard Vcc supply voltage and the coefficient of fluctuation does not exceed 0.1 V/ms at instantaneous power switching.

### **■ BLOCK DIAGRAM**



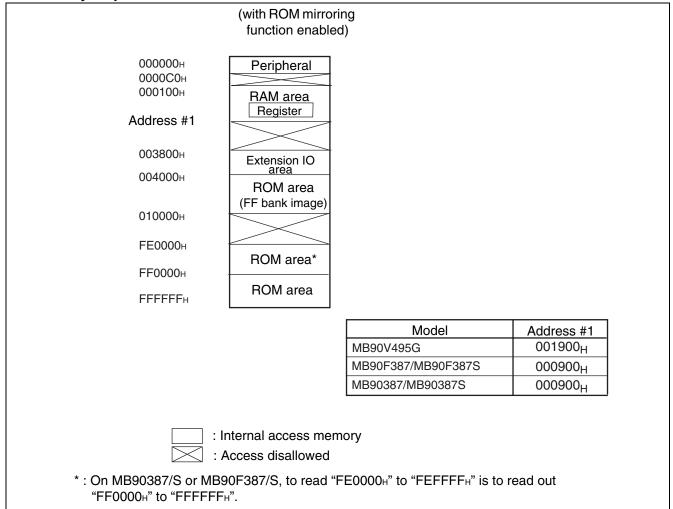
### **■ MEMORY MAP**

MB90385 series allows specifying a memory access mode "single chip mode."

### 1. Memory allocation of MB90385

MB90385 series model has 24-bit wide internal address bus and up to 24-bit bus of external address bus. A maximum of 16-Mbyte memory space of external access memory is accessible.

### 2. Memory map



Note: When internal ROM is operating, F<sup>2</sup>MC-16LX allows viewing ROM data image on FF bank at upper-level of 00 bank. This function is called "mirroring ROM," which allows effective use of C compiler small model. F<sup>2</sup>MC-16LX assigns the same low order 16-bit address to FF bank and 00 bank, which allows referencing table in ROM without specifying "far" using pointer.

For example, when accessing to "00C000H", ROM data at "FFC000H" is accessed actually. However, because ROM area of FF bank exceeds 48 Kbytes, viewing all areas is not possible on 00 bank image. Because ROM data of "FF4000H" to "FFFFFFH" is viewed on "004000H" to "00FFFFH" image, store a ROM data table in area "FF4000H" to "FFFFFFHH."

### ■ I/O MAP

Address	Register abbreviation	Register	Read/ Write	Resource	Initial value	
000000н		(Reserv	ed area) *			
000001н	PDR1	Port 1 data register	R/W	Port 1	XXXXXXXXB	
000002н	PDR2	Port 2 data register	R/W	Port 2	XXXXXXXX	
000003н	PDR3	Port 3 data register	R/W	Port 3	XXXXXXXX	
000004н	PDR4	Port 4 data register	R/W	Port 4	XXXXXXXX	
000005н	PDR5	Port 5 data register	R/W	Port 5	XXXXXXXXB	
000006н to 000010н		(Reserv	ed area) *			
000011н	DDR1	Port 1 direction data register	R/W	Port 1	0000000в	
000012н	DDR2	Port 2 direction data register	R/W	Port 2	0000000В	
000013н	DDR3	Port 3 direction data register	R/W	Port 3	000Х0000в	
000014н	DDR4	Port 4 direction data register	R/W	Port 4	ХХХ00000в	
000015н	DDR5	Port 5 direction data register	R/W	Port 5	0000000в	
000016н to 00001Ан		(Reserved area) *				
00001Вн	ADER	Analog input permission register	R/W	8/10-bit A/D converter	11111111В	
00001Сн to 000025н		(Reserv	ed area) *			
000026н	SMR1	Serial mode register 1	R/W		0000000в	
000027н	SCR1	Serial control register 1	R/W, W		00000100в	
000028н	SIDR1/ SODR1	Serial input data register 1/ Serial output data register 1	R, W	UART1	XXXXXXXXB	
000029н	SSR1	Serial status data register 1	R, R/W		00001000в	
00002Ан		(Reserv	ed area) *	1	-1	
00002Вн	CDCR1	Communication prescaler control register 1	R/W	UART1	0ХХХ0000в	
00002Сн to 00002Fн		(Reserv	ed area) *			
000030н	ENIR	DTP/External interrupt permission register	R/W		0000000В	
000031н	EIRR	DTP/External interrupt permission register	R/W	DTP/External interrupt	XXXXXXXXB	
000032н	ELVD	Detection level cotting register	R/W	1	0000000В	
000033н	ELVR	Detection level setting register	R/W	1	0000000в	

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Address	Register abbreviation	Register	Read/ Write	Resource	Initial value
000034н	ADCS	A/D control status register	R/W		0000000В
000035н	ADCS	A/D control status register	R/W, W	8/10-bit	0000000В
000036н	ADCR	A/D data register	W, R	A/D converter	XXXXXXXXB
000037н	ADCR	A/D data register	R	]	00101XXXв
000038н to 00003Fн		(Reserve	ed area) *		
000040н	PPGC0	PPG0 operation mode control register	R/W, W		0X000XX1в
000041н	PPGC1	PPG1 operation mode control register	R/W, W	8/16-bit PPG timer 0/1	0Х00001в
000042н	PPG01	PPG0/1 count clock selection register	R/W		000000XX <sub>B</sub>
000043н		(Reserve	ed area) *		
000044н	PPGC2	PPG2 operation mode control register	R/W, W	8/16-bit PPG timer 2/3	0Х000ХХ1в
000045н	PPGC3	PPG3 operation mode control register	R/W, W		0Х00001в
000046н	PPG23	PPG2/3 count clock selection register	R/W		000000XXв
000047н to 00004Fн		(Reserve	ed area) *		
000050н	IPCP0	Input conture data register 0	R		XXXXXXXXB
000051н	IPCPU	Input capture data register 0	n		XXXXXXXXB
000052н	IPCP1	Input conture data register 1	В	]	XXXXXXXXB
000053н	IPCPT	Input capture data register 1	R		XXXXXXXXB
000054н	ICS01	Input conture control status register	DAM	16-bit input/output	0000000В
000055н	ICS23	Input capture control status register	R/W		0000000в
000056н	TCDT	Timor countar data register	R/W	]	0000000В
000057н	וטטו	Timer counter data register	□/ <b>VV</b>		0000000в
000058н	TCCS	Timer counter control status register	R/W	]	0000000в
000059н		(Reserve	ed area) *		
00005Ан	IPCP2	Input capture data register 2	R		XXXXXXXX
00005Вн	15052	Input capture data register 2	ח	16-bit input/output	XXXXXXXX
00005Сн	IPCP3	Input capture data register 2	R	timer	XXXXXXXX
00005Dн	IFUES	Input capture data register 3	n		XXXXXXXXB

Address	Register abbreviation	Register	Read/ Write	Resource	Initial value
00005Eн to 000065н		(Reserv	ed area) *		
000066н	TMCSR0		R/W	- 16-bit reload timer 0	0000000В
000067н	TIVICONU	Timer control status register	R/W	To-bit reload timer of	XXXX0000 <sub>B</sub>
000068н	TMCSR1	Timer control status register	R/W	- 16-bit reload timer 1	0000000В
000069н	TIVICONT		R/W	- 10-bit reload timer 1	XXXX0000 <sub>B</sub>
00006Ан to 00006Ен		(Reserv	red area) *		
00006Fн	ROMM	ROM mirroring function selection register	W	ROM mirroring function selection module	XXXXXXX1 <sub>B</sub>
000070н to 00007Fн		(Reserv	ed area) *		
000080н	BVALR	Message buffer enabling register	R/W	CAN controller	0000000В
000081н		(Reserv	ed area) *		
000082н	TREQR	Send request register	R/W	CAN controller	0000000В
000083н		(Reserv	ed area) *		
000084н	TCANR	Send cancel register	W	CAN controller	0000000В
000085н		(Reserv	ed area) *		
000086н	TCR	Send completion register	R/W	CAN controller	0000000В
000087н		(Reserv	ed area) *		
000088н	RCR	Receive completion register	R/W	CAN controller	0000000В
000089н		(Reserv	ed area) *		
00008Ан	RRTRR	Receive RTR register	R/W	CAN controller	0000000В
00008Вн		(Reserv	red area) *		
00008Сн	ROVRR	Receive overrun register	R/W	CAN controller	0000000В
00008Dн		(Reserv	ed area) *	·	
00008Ен	RIER	Receive completion interrupt permission register	R/W	CAN controller	00000000в
00008Fн to 00009Dн	(Reserved area) *				
00009Ен	PACSR	Address detection control register	R/W	Address matching detection function	00000000в
00009Fн	DIRR	Delay interrupt request generation/ release register	R/W	Delay interrupt generation module	XXXXXXX0 <sub>B</sub>

Address	Register abbreviation	Register	Read/ Write	Resource	Initial value
0000А0н	LPMCR	Lower power consumption mode control register	W,R/W	Lower power consumption mode	00011000в
0000А1н	CKSCR	Clock selection register	R,R/W	Clock	11111100в
0000A2н to 0000A7н		(Reserv	red area) *		
0000А8н	WDTC	Watchdog timer control register	R,W	Watchdog timer	XXXXX111 <sub>B</sub>
0000А9н	TBTC	Time-base timer control register	R/W,W	Time-base timer	1XX00100 <sub>B</sub>
0000ААн	WTC	Watch timer control register	R,R/W	Watch timer	1Х001000в
0000ABн to 0000ADн		(Reserv	ved area) *		
0000АЕн	FMCS	Flash memory control status register	R,W,R/W	512k-bit Flash memory	000Х0000в
0000АГн		(Reserv	ved area) *		
0000В0н	ICR00	Interrupt control register 00			00000111в
0000В1н	ICR01	Interrupt control register 01			00000111в
0000В2н	ICR02	Interrupt control register 02			00000111в
0000ВЗн	ICR03	Interrupt control register 03			00000111в
0000В4н	ICR04	Interrupt control register 04			00000111в
0000В5н	ICR05	Interrupt control register 05			00000111в
0000В6н	ICR06	Interrupt control register 06			00000111в
0000В7н	ICR07	Interrupt control register 07	R/W	Interrupt controller	00000111в
0000В8н	ICR08	Interrupt control register 08		TitleTupt Controller	00000111в
0000В9н	ICR09	Interrupt control register 09			00000111в
0000ВАн	ICR10	Interrupt control register 10	]		00000111в
0000ВВн	ICR11	Interrupt control register 11	]		00000111в
0000ВСн	ICR12	Interrupt control register 12			00000111в
0000ВДн	ICR13	Interrupt control register 13	]		00000111в
0000ВЕн	ICR14	Interrupt control register 14	]		00000111в
0000ВГн	ICR15	Interrupt control register 15	]		00000111в
0000С0н to 0000FFн		(Reserv	ved area) *		(Continue)

Address	Register abbreviation	Register	Read/ Write	Resource	Initial value
001FF0н		Detection address setting register 0 (low-order)			XXXXXXXXB
001FF1н	PADR0	Detection address setting register 0 (middle-order)	R/W	Address matching	XXXXXXXXB
001FF2н		Detection address setting register 0 (high-order)			XXXXXXXXB
001FF3н		Detection address setting register 1 (low-order)		detection function	XXXXXXXXB
001FF4н	PADR1	Detection address setting register 1 (middle-order)	R/W		XXXXXXXXB
001FF5н		Detection address setting register 1 (high-order)			XXXXXXXXB
003900н	TMR0/	16-bit timer register 0/16-bit reload	R,W	16-bit reload timer 0	XXXXXXXX
003901н	TMRLR0	register	11, VV		XXXXXXXX
003902н	TMR1/	16-bit timer register 1/16-bit reload	R,W	16-bit reload timer 1	XXXXXXXX
003903н	TMRLR1	register R, W TO-bit Teload timer 1			XXXXXXXX
003904н					
to 00390Fн		(Reserve	d area) *		
003910н	PRLL0	PPG0 reload register L	R/W		XXXXXXXX
003911н	PRLH0	PPG0 reload register H	R/W	1	XXXXXXXX
003912н	PRLL1	PPG1 reload register L	R/W	1	XXXXXXXX
003913н	PRLH1	PPG1 reload register H	R/W	- 8/16-bit PPG timer	XXXXXXXX
003914н	PRLL2	PPG2 reload register L	R/W		XXXXXXXX
003915н	PRLH2	PPG2 reload register H	R/W		XXXXXXXX
003916н	PRLL3	PPG3 reload register L	R/W		XXXXXXXX
003917н	PRLH3	PPG3 reload register H	R/W		XXXXXXXX
003918н to 00392Fн		(Reserve	d area) *		
003930н to 003BFFн		(Reserve	d area) *		
003С00н to 003С0Fн	RAM (General-purpose RAM)				

Address	Register abbreviation	Register	Read/ Write	Resource	Initial value		
003С10н to 003С13н	IDR0	ID register 0	ID register 0 R/W				
003С14н to 003С17н	IDR1	ID register 1	R/W		XXXXXXXXB to XXXXXXXXXB		
003С18н to 003С1Вн	IDR2	ID register 2	R/W		XXXXXXXB to XXXXXXXXB		
003С1Сн to 003С1Fн	IDR3	ID register 3	R/W		XXXXXXXB to XXXXXXXXB		
003С20н to 003С23н	IDR4	ID register 4	R/W	_	XXXXXXXB to XXXXXXXXB		
003С24н to 003С27н	IDR5	D register 5 R/W	XXXXXXXB to XXXXXXXXB				
003С28н to 003С2Вн	IDR6	ID register 6	R/W	CAN controller	XXXXXXXB to XXXXXXXXB		
003С2Сн to 003С2Fн	IDR7	ID register 7	R/W		XXXXXXXB to XXXXXXXXB		
003С30н, 003С31н	DLCR0	DLC register 0	R/W		XXXXXXXXB, XXXXXXXXB		
003С32н, 003С33н	DLCR1	DLC register 1	R/W		XXXXXXXXB, XXXXXXXXB		
003С34н, 003С35н	DLCR2	DLC register 2 R/W DLC register 3 R/W DLC register 4 R/W		_	XXXXXXXX <sub>B</sub> , XXXXXXXX <sub>B</sub>		
003С36н, 003С37н	DLCR3				XXXXXXX <sub>B</sub> , XXXXXXXX <sub>B</sub>		
003С38н, 003С39н	DLCR4				XXXXXXXXB, XXXXXXXXB		
003С3Ан, 003С3Вн	DLCR5	DLC register 5	R/W		XXXXXXXB, XXXXXXXB		

Address	Register abbreviation	Register	Read/ Write	Resource	Initial value					
003С3Сн, 003С3Dн	DLCR6	DLC register 6	R/W		XXXXXXXXB, XXXXXXXXB					
003С3Ен, 003С3Fн	DLCR7	DLC register 7	R/W		XXXXXXXXB, XXXXXXXXB					
003С40н to 003С47н	DTR0	Data register 0	R/W		XXXXXXXXB to XXXXXXXXB					
003С48н to 003С4Fн	DTR1	Data register 1	R/W		XXXXXXXXB to XXXXXXXXB					
003С50н to 003С57н	DTR2	Data register 2	R/W		XXXXXXXXB to XXXXXXXXB					
003С58н to 003С5Fн	DTR3	Data register 3	R/W	CAN controller	XXXXXXXXB to XXXXXXXXB					
003С60н to 003С67н	DTR4	Data register 4	R/W		XXXXXXXXB to XXXXXXXXB					
003С68н to 003С6Fн	DTR5	Data register 5	R/W		XXXXXXXXB to XXXXXXXXB					
003С70н to 003С77н	DTR6	Data register 6	R/W		XXXXXXXXB to XXXXXXXXB					
003С78н to 003С7Fн	DTR7	Data register 7	R/W		XXXXXXXXB to XXXXXXXXB					
003С80н to 003СFFн		(Reserv	ed area) *							
003D00н, 003D01н	CSR	Control status register	R/W, R	CAN controller	0XXXX001в, 00XXX000в					
003D02н	LEIR	Last event display register	R/W		000ХХ000в					
003D03н		(Reserv	ed area) *							
003D04н, 003D05н	RTEC	Send/receive error counter	R		0000000в, 0000000в					
003D06н, 003D07н	BTR	Bit timing register	R/W	CAN controller	11111111в, X1111111в					
003D08н	IDER	IDE register	R/W	<u> </u>	XXXXXXXX					
003D09н		(Reserved area) *								
003D0Ан	TRTRR	Send RTR register	R/W	CAN controller	0000000B					

### (Continued)

Address	Register abbreviation	Register	Read/ Write	Resource	Initial value					
003D0Вн		(Reserve	ed area) *							
003D0Сн	RFWTR	Remote frame receive wait register	R/W	CAN controller	XXXXXXXX					
003D0Dн		(Reserve	ed area) *							
003D0Eн	TIER	Send completion interrupt permission register	R/W	CAN controller	0000000В					
003D0Fн		(Reserve								
003D10н, 003D11н	AMSR	Acceptance mask selection register	R/W	CAN controller	XXXXXXXX <sub>B</sub> , XXXXXXXX <sub>B</sub>					
003D12н, 003D13н		(Reserve	ed area) *							
003D14н to 003D17н	AMR0	Acceptance mask register 0	R/W	- CAN controller	XXXXXXXB to XXXXXXXXB					
003D18н to 003D1Вн	AMR1	Acceptance mask register 1	R/W	CAN controller	XXXXXXXB to XXXXXXXXB					
003D1Сн to 003DFFн		(Reserve	ed area) *							
003E00н to 003EFFн		(Reserved area) *								
003FF0н to 003FFFн	(Reserved area) *									

### Initial values:

0 : Initial value of this bit is "0."1 : Initial value of this bit is "1."

X: Initial value of this bit is undefined.

\*: "Reserved area" should not be written anything. Result of reading from "Reserved area" is undefined.

### ■ INTERRUPT SOURCES, INTERRUPT VECTORS, AND INTERRUPT CONTROL REGISTERS

Intowers a compa	El <sup>2</sup> OS	lr	nterrup	t vector	Interrupt c	ontrol register	Dul a ultr +2
Interrupt source	readiness	Nun	nber	Address	ICR	Address	Priority*3
Reset	×	#08	08н	FFFFDC⊢	_	_	High
INT 9 instruction	×	#09	09н	FFFFD8 <sub>H</sub>	_	_	$\uparrow$
Exceptional treatment	×	#10	ОАн	FFFFD4 <sub>H</sub>	_	_	
CAN controller reception completed (RX)	×	#11	0Вн	FFFFD0 <sub>H</sub>			
CAN controller transmission completed (TX) / Node status transition (NS)	×	#12	0Сн	FFFFCCH	ICR00	0000В0н*1	
Reserved	×	#13	0Дн	FFFFC8 <sub>H</sub>	ICD04	000001	
Reserved	×	#14	0Ен	FFFFC4 <sub>H</sub>	ICR01	0000В1н	
CAN wakeup	Δ	#15	0Fн	FFFFC0 <sub>H</sub>	ICDOO	000000 *1	1
Time-base timer	×	#16	10н	FFFFBCH	ICR02	0000B2н*1	
16-bit reload timer 0	Δ	#17	11н	FFFFB8 <sub>H</sub>	IODOO	000000 *1	
8/10-bit A/D converter	Δ	#18	12н	FFFFB4 <sub>H</sub>	ICR03	0000ВЗн*1	
16-bit free-run timer overflow	Δ	#19	13н	FFFFB0 <sub>H</sub>	ICD04	0000004 *1	
Reserved	×	#20	14н	FFFFAC⊦	ICR04	0000В4н*1	
Reserved	×	#21	15н	FFFFA8 <sub>H</sub>	IODOF	000005 *1	
PPG timer ch0, ch1 underflow	×	#22	16н	FFFFA4 <sub>H</sub>	ICR05	0000В5н*1	
Input capture 0-input	Δ	#23	17н	FFFFA0 <sub>H</sub>	ICDOC	0000DC *1	
External interrupt (INT4/INT5)	Δ	#24	18н	FFFF9C <sub>H</sub>	ICR06	0000В6н*1	
Input capture 1-input	Δ	#25	19н	FFFF98 <sub>H</sub>	ICR07	0000D7*2	
PPG timer ch2, ch3 underflow	×	#26	1Ан	FFFF94 <sub>H</sub>	ICHU/	0000В7н*2	
External interrupt (INT6/INT7)	Δ	#27	1Вн	FFFF90 <sub>H</sub>	ICR08	0000B8н*1	
Watch timer	Δ	#28	1Сн	FFFF8C <sub>H</sub>	ICHU	ООООВОН .	
Reserved	×	#29	1Dн	FFFF88 <sub>H</sub>			
Input capture 2-input Input capture 3-input	×	#30	1Ен	FFFF84 <sub>H</sub>	ICR09	0000В9н*1	
Reserved	×	#31	1F <sub>H</sub>	FFFF80 <sub>H</sub>	ICR10	0000BAн*1	
Reserved	×	#32	20н	FFFF7C <sub>H</sub>		UUUUDAH '	
Reserved	×	#33	21н	FFFF78⊦	ICD11	OD44 0000DD #1	
Reserved	×	#34	22н	FFFF74 <sub>H</sub>	IUNII	ICR11 0000BB <sub>H</sub> *1	
Reserved	×	#35	23н	FFFF70 <sub>H</sub>	10040 20000 #1		$\downarrow$
16-bit reload timer 1	0	#36	24н	FFFF6C <sub>H</sub>	ICR12	0000BCн*1	Low

### (Continued)

Interrupt source	El <sup>2</sup> OS	In	terrup	t vector	Interrupt c	ontrol register	Priority*3
interrupt source	readiness	Nun	nber	Address	ICR	Address	Priority
UART1 reception completed	0	#37	25н	FFFF68⊦	ICR13	0000BDн*1	High
UART1 transmission completed	Δ	#38	26н	FFFF64 <sub>H</sub>	ICHIS	OOOODDH .	<b>↑</b>
Reserved	×	#39	27н	FFFF60 <sub>H</sub>	ICR14	0000ВЕн*1	
Reserved	×	#40	28н	FFFF5C <sub>H</sub>	ICN 14	OOOOBEH .	
Flash memory	×	#41	29н	FFFF58 <sub>H</sub>			
Delay interrupt generation module	×	#42	2Ан	FFFF54 <sub>H</sub>	ICR15	0000BFн*1	↓ Low

○ : Available

× : Unavailable

: Available El<sup>2</sup>OS function is provided.

 $\Delta$ : Available when a cause of interrupt sharing a same ICR is not used.

- \*1 : Peripheral functions sharing an ICR register have the same interrupt level.
  - If peripheral functions share an ICR register, only one function is available when using expanded intelligent I/O service.
  - If peripheral functions share an ICR register, a function using expanded intelligent I/O service does not allow interrupt by another function.
- \*2: Input capture 1 corresponds to El<sup>2</sup>OS, however, PPG does not. When using El<sup>2</sup>OS by input capture 1, interrupt should be disabled for PPG.
- \*3 : Priority when two or more interrupts of a same level occur simultaneously.

### **■ PERIPHERAL RESOURCES**

#### 1. I/O Ports

The I/O ports are used as general-purpose input/output ports (parallel I/O ports). The MB60385 series model is provided with 5 ports (34 inputs). The ports function as input/output pins for peripheral functions also.

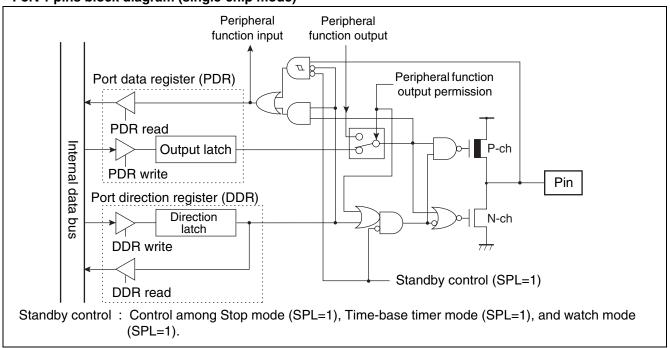
### • I/O port functions

An I/O port, using port data resister (PDR), outputs the output data to I/O pin and input a signal input to I/O port. The port direction register (DDR) specifies direction of input/output of I/O pins on a bit-by-bit basis.

The following summarizes functions of the ports and sharing peripheral functions:

- Port 1 : General-purpose input/output port, used also for PPG timer output and input capture inputs.
- Port 2: General-purpose input/output port, used also for reload timer input/output and external interrupt input.
- Port 3: General-purpose input/output port, used also for A/D converter activation trigger pin.
- Port 4: General-purpose input/output port, used also for UART input/output and CAN controller send/receive pin.
- Port 5: General-purpose input/output port, used also analog input pin.

### Port 1 pins block diagram (single-chip mode)



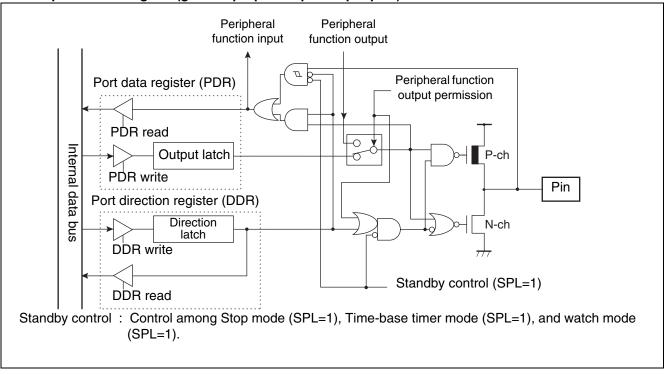
#### • Port 1 registers (single-chip mode)

- Port 1 registers include port 1 data register (PDR1) and port 1 direction register (DDR1).
- The bits configuring the register correspond to port 1 pins on a one-to-one basis.

### Relation between port 1 registers and pins

Port name	Bits of register and corresponding pins								
Port 1	PDR1, DDR1	bit7	bit6	bit5	bit4	bit3	bit2	bit1	bit0
l oit i	Corresponding pins	P17	P16	P15	P14	P13	P12	P11	P10

### • Port 2 pins block diagram (general-purpose input/output port)



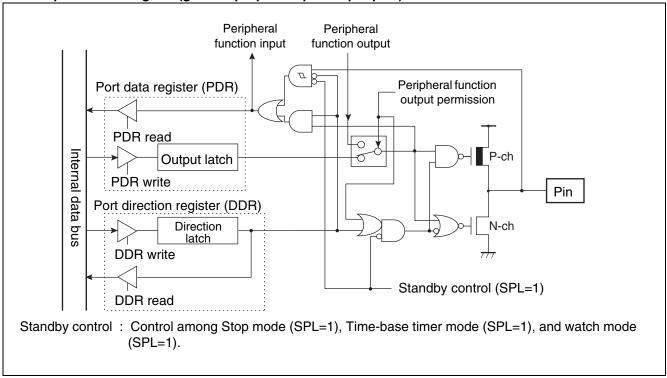
### • Port 2 registers

- Port 2 registers include port 2 data register (PDR2) and port 2 direction register (DDR2).
- The bits configuring the register correspond to port 2 pins on a one-to-one basis.

### Relation between port 2 registers and pins

Port name	Bits of register and corresponding pins									
Port 2	PDR2,DDR2	bit7	bit6	bit5	bit4	bit3	bit2	bit1	bit0	
I OIL Z	Corresponding pins	P27	P26	P25	P24	P23	P22	P21	P20	

### • Port 3 pins block diagram (general-purpose input/output port)



#### • Port 3 registers

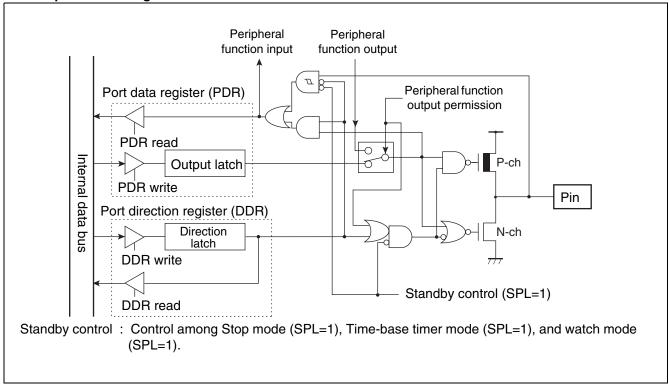
- Port 3 registers include port 3 data register (PDR3) and port 3 direction register (DDR3).
- The bits configuring the register correspond to port 3 pins on a one-to-one basis.

### Relation between port 3 registers and pins

Port name	Bits of register and corresponding pins								
Port 3	PDR3, DDR3	bit7	bit6	bit5	bit4	bit3	bit2	bit1	bit0
1 011 3	Corresponding pins	P37	P36*	P35*	_	P33	P32	P31	P30

<sup>\*:</sup> P35 and P36 do not exist on MB90387and MB90F387.

### • Port 4 pins block diagram



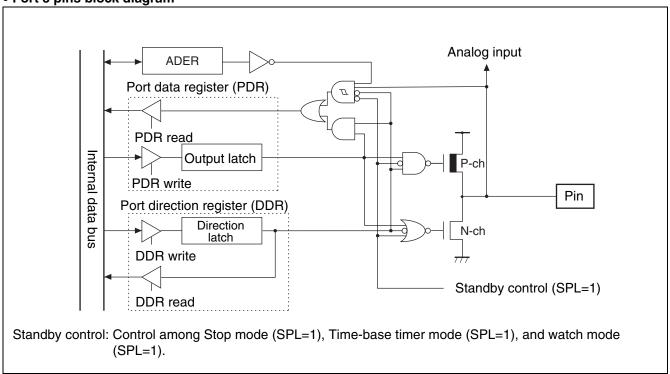
### Port 4 registers

- Port 4 registers include port 4 data register (PDR4) and port 4 direction register (DDR4).
- The bits configuring the register correspond to port 4 pins on a one-to-one basis.

### Relation between port 4 registers and pins

Port name	Bits of register and corresponding pins								
Port 4	PDR4, DDR4	_	_	_	bit4	bit3	bit2	bit1	bit0
1 011 4	Corresponding pins		_	_	P44	P43	P42	P41	P40

### • Port 5 pins block diagram



### • Port 5 registers

- Port 5 registers include port 5 data register (PDR5), port 5 direction register (DDR5), and analog input permission register (ADER).
- Analog input permission register (ADER) allows or disallows input of analog signal to the analog input pin.
- The bits configuring the register correspond to port 5 pins on a one-to-one basis.

### Relation between port 5 registers and pins

Port name	Bits of register and corresponding pins										
	PDR5, DDR5	bit7	bit6	bit5	bit4	bit3	bit2	bit1	bit0		
Port 5	ADER	ADE7	ADE6	ADE5	ADE4	ADE3	ADE2	ADE1	ADE0		
	Corresponding pins	P57	P56	P55	P54	P53	P52	P51	P50		

#### 2. Time-Base Timer

The time-base time is an 18-bit free-run counter (time-base timer counter) that counts up in synchronization with the main clock (dividing main oscillation clock by 2).

- Four choices of interval time are selectable, and generation of interrupt request is allowed for each interval time.
- Provides operation clock signal to oscillation stabilizing wait timer and peripheral functions.

### • Interval timer function

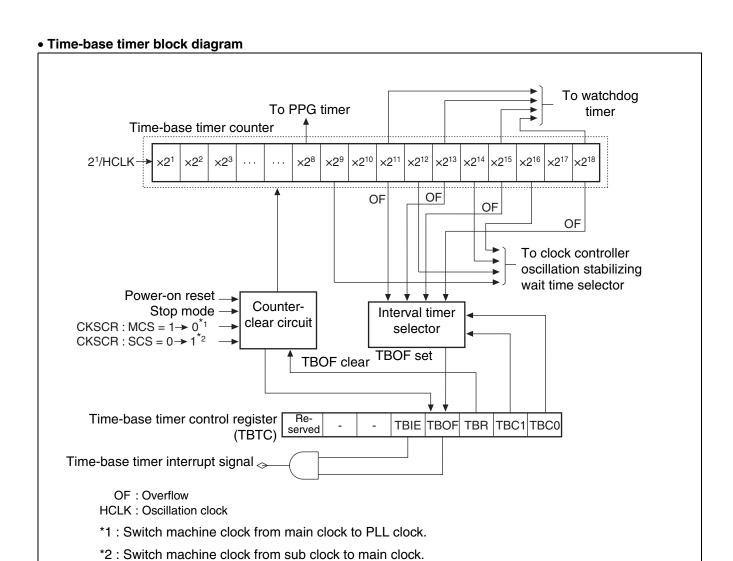
- When the counter of time-base timer reaches an interval time specified by interval time selection bit (TBTC:TBC1, TBC0), an overflow (carrying-over) occurs (TBTC: TBOF=1) and interrupt request is generated.
- If an interrupt by overflow is permitted (TBTC: TBIE=1), an interrupt is generated when overflow occurs (TBTC: TBOF=1).
- The following four interval time settings are selectable :

### Interval time of time-base timer

Count clock	Interval time
	212/HCLK (Approx. 1.0 ms)
2/UCLK (0.5)	2 <sup>14</sup> /HCLK (Approx. 4.1 ms)
2/HCLK (0.5 μs)	2 <sup>16</sup> /HCLK (Approx. 16.4 ms)
	2 <sup>19</sup> /HCLK (Approx. 131.1 ms)

HCLK: Oscillation clock

Values in parentheses "()" are those under operation of 4-MHz oscillation clock.



Actual interrupt request number of time-base timer is as follows:

Interrupt request number: #16 (10H)

### 3. Watchdog Timer

The watchdog timer is a 2-bit counter that uses time-base timer or watch timer as count clock. If the counter is not cleared within an interval time, CPU is reset.

### •Watchdog timer functions

- The watchdog timer is a timer counter that prevents runaway of a program. Once a watchdog timer is activated, the counter of watchdog timer must always be cleared within a specified time of interval. If specified interval time elapses without clearing the counter of a watchdog timer, CPU resetting occurs. This is the function of a watchdog timer.
- The interval time of a watchdog timer is determined by a clock cycle, which is input as a count clock. Watchdog resetting occurs between a minimum time and a maximum time specified.
- The output target of a clock source is specified by the watchdog clock selection bit (WTC: WDCS) in the watch timer control register.
- Interval time of a watchdog timer is specified by the time-base timer output selection bit / watch timer output selection bit (WDTC: WT1, WT0) in the watchdog timer control register.

### Interval timer of watchdog timer

Min	Max	Clock cycle	Min	Max	Clock cycle
Approx. 3.58 ms	Approx. 4.61 ms	(2 <sup>14</sup> ±2 <sup>11</sup> ) /HCLK	Approx. 0.457 s	Approx. 0.576 s	(2 <sup>12</sup> ±2 <sup>9</sup> ) /SCLK
Approx. 14.33 ms	Approx. 18.3 ms	(2 <sup>16</sup> ±2 <sup>13</sup> ) /HCLK	Approx. 3.584 s	Approx. 4.608 s	(2 <sup>15</sup> ±2 <sup>12</sup> ) /SCLK
Approx. 57.23 ms	Approx. 73.73 ms	(2 <sup>18</sup> ±2 <sup>15</sup> ) /HCLK	Approx. 7.168 s	Approx. 9.216 s	(2 <sup>16</sup> ±2 <sup>13</sup> ) /SCLK
Approx. 458.75 ms	Approx. 589.82 ms	(2 <sup>21</sup> ±2 <sup>18</sup> ) /HCLK	Approx. 14.336 s	Approx. 18.432 s	(2 <sup>17</sup> ±2 <sup>14</sup> ) /SCLK

HCLK: Oscillation clock (4 MHz), CSCLK: Sub clock (8.192 kHz)

Notes: • If the time-base timer is cleared when watchdog timer count clock is used as time base timer output (carry-over signal), watchdog reset time may become longer.

• When using the sub clock as machine clock, be sure to specify watchdog timer clock source selection bit (WDCS) in watch timer control register (WTC) at "0," selecting output of watch timer.

#### • Watchdog timer block diagram Watch timer control register (WTC) Watchdog timer control register(WDTC) WRST ERST SRST WTE WT1 WT0 PONR WDCS Watchdog timer 2 Activate Reset occurs \_ Watchdog Counter Shift to sleep mode -2-bit Internal reset Count clock reset clear control Shift to time-base counter generation generation selector circuit timer mode circuit circuit Shift to watch mode Clear Shift to stop mode Time-base timer counter Main clock $\times 2^{8} \times 2^{9} \times 2^{10} \times 2^{11} \times 2^{12} \times 2^{13} \times 2^{14} \times 2^{15} \times 2^{16} \times 2^{17} \times 2^{18}$ (dividing HCLK by 2) Watch counter Sub clock x 22 $\times 2^5 \times 2^6 \times 2^7 \times 2^8$ $\times 2^{9} \times 2^{10} \times 2^{11} \times 2^{12} \times 2^{13} \times 2^{14} \times 2^{15}$ **SCLK** HCLK: Oscillation clock SCLK: Sub clock

### 4. 16-bit Input/Output Timer

The 16-bit input/output timer is a compound module composed of 16-bit free-run timer, (1 unit) and input capture (2 units, 4 input pins). The timer, using the 16-bit free-run timer as a basis, enables measurement of clock cycle of an input signal and its pulse width.

### Configuration of 16-bit input/output timer

The 16-bit input/output timer is composed of the following modules:

- 16-bit free-run timer (1 unit)
- Input capture (2 units, 2 input pins per unit)

### • Functions of 16-bit input/output timer

### (1) Functions of 16-bit free-run timer

The 16-bit free-run timer is composed of 16-bit up counter, timer counter control status register, and prescaler. The 16-bit up counter increments in synchronization with dividing ratio of machine clock.

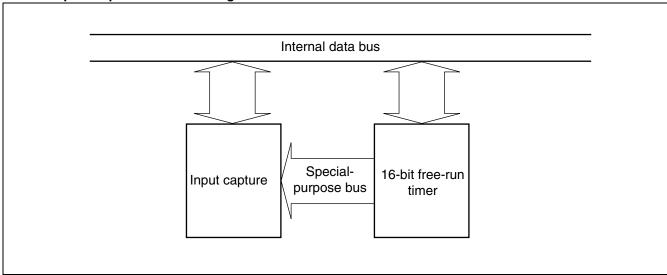
- Count clock is set among four types of machine clock dividing rates.
- Generation of interrupt is allowed by counter value overflow.
- Activation of expanded intelligent I/O service (El<sup>2</sup>OS) is allowed by interrupt generation.
- Counter value of 16-bit free-run timer is cleared to "0000<sub>H</sub>" by either resetting or software-clearing with timer count clear bit (TCCS: CLR).
- Counter value of 16-bit free-run timer is output to input capture, which is available as base time for capture
  operation.

### (2) Functions of input capture

The input capture, upon detecting an edge of a signal input to the input pin from external device, stores a counter value of 16-bit free-run timer at the time of detection into the input capture data register. The function includes the input capture data registers corresponding to four input pins, input capture control status register, and edge detection circuit.

- Rising edge, falling edge, and both edges are selectable for detection.
- Generating interrupt on CPU is allowed by detecting an edge of input signal.
- Expanded intelligent I/O service (EI2OS) is activated by interrupt generation.
- The four input capture input pins and input capture data registers allows monitoring of a maximum of four events.

### • 16-bit input/output timer block diagram



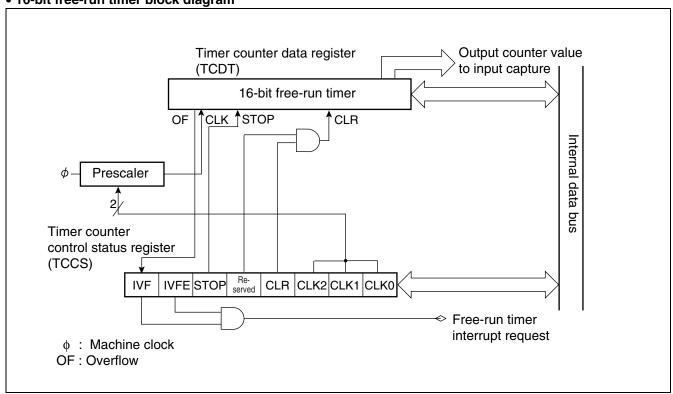
#### • 16-bit free-run timer

Counter value of 16-bit free-run timer is used as reference time (base time) of input capture.

### • Input capture

Input capture detects rising edge, falling edge or both edges and retains a counter value of 16-bit free-run timer. Detection of edge on input signal is allowed to generate interrupt.

### • 16-bit free-run timer block diagram



### • Detailed pin assignment on block diagram

The 16-bit input/output timer includes a 16-bit free-run timer. Interrupt request number of the 16-bit free-run timer is as follows:

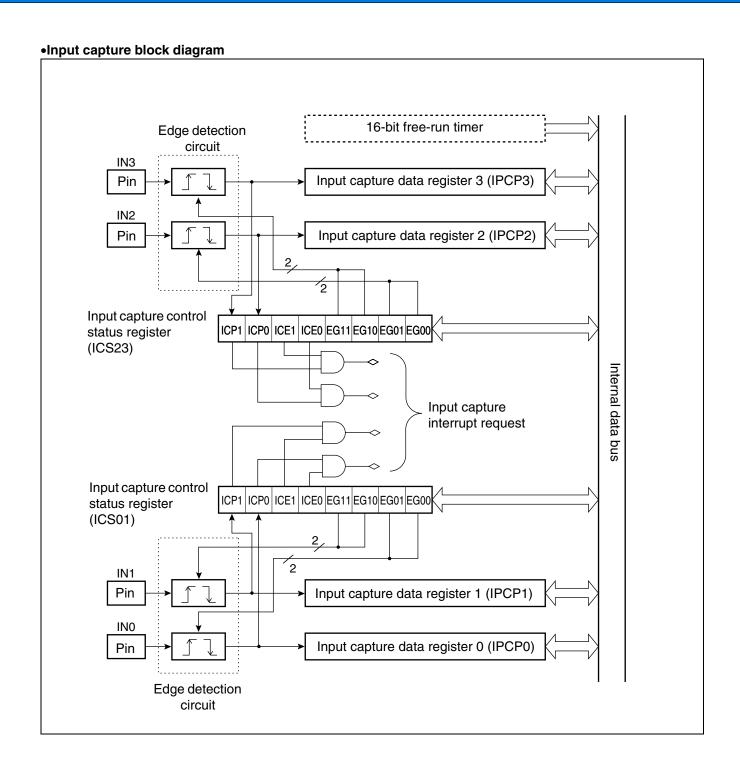
Interrupt request number: 19 (13H)

### • Prescaler

The prescaler divides a machine clock and provides a counter clock to the 16-bit up counter. Dividing ratio of the machine clock is specified by timer counter control status register (TCCS) among four values.

### • Timer counter data register (TCDT)

The timer counter data register is a 16-bit up counter. A current counter value of the 16-bit free-run timer is read. Writing a value during halt of the counter allows setting an arbitrary counter value.



#### 5. 16-bit Reload Timer

The 16-bit reload timer has the following functions:

- Count clock is selectable among 3 internal clocks and external event clock.
- Activation trigger is selectable between software trigger and external trigger.
- Generation of CPU interrupt is allowed upon occurrence of underflow on 16-bit timer register. Available as an interval timer using the interrupt function.
- When underflow of 16-bit timer register (TMR) occurs, one of two reload modes is selectable between oneshot mode that halts counting operation of TMR, and reload mode that reloads 16-bit reload register value to TMR, continuing TMR counting operation.
- The 16-bit reload timer is ready for expanded intelligent I/O service (El<sup>2</sup>OS).
- MB90385 series device has 2 channels of built-in 16-bit reload timer.

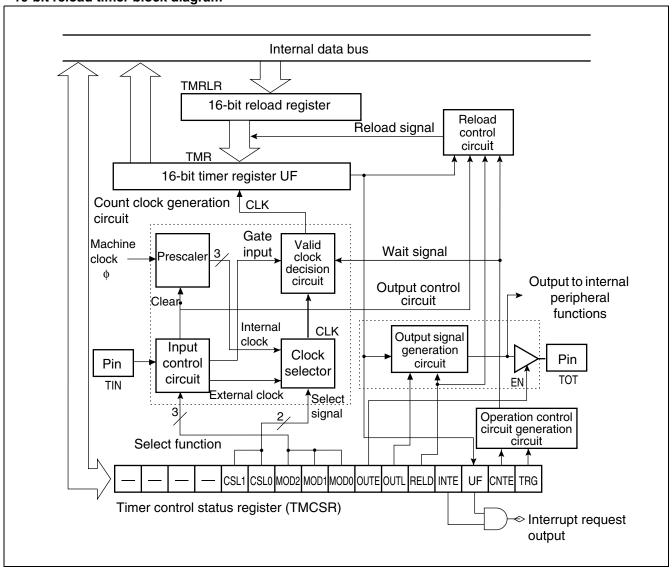
#### Operation mode of 16-bit reload timer

Count clock	Activation trigger	Operation upon underflow		
Internal clock mode	Software trigger, external trigger	One-shot mode, reload mode		
Event count mode	Software trigger	One-shot mode, reload mode		

#### • Internal clock mode

- The 16-bit reload timer is set to internal clock mode, by setting count clock selection bit (TMCSR: CSL1, CSL0) to "00<sub>B</sub>", "01<sub>B</sub>", "10<sub>B</sub>".
- In the internal clock mode, the counter decrements in synchronization with the internal clock.
- Three types of count clock cycles are selectable by count clock selection bit (TMCSR: CSL1, CSL0) in timer control status register.
- Edge detection of software trigger or external trigger is specified as an activation trigger.

## • 16-bit reload timer block diagram



#### 6. Watch Timer Outline

The watch timer is a 15-bit free-run counter that increments in synchronization with sub clock.

- Interval time is selectable among 7 choices, and generation of interrupt request is allowed for each interval.
- Provides operation clock to the subclock oscillation stabilizing wait timer and watchdog timer.
- Always uses subclock as a count clock regardless of settings of clock selection register (CKSCR).

#### • Interval timer function

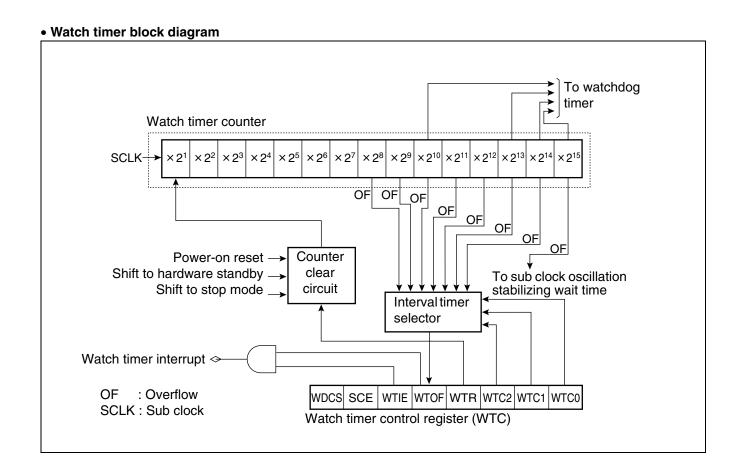
- In the watch timer, a bit corresponding to the interval time overflows (carry-over) when an interval time, which is specified by interval time selection bit, is reached. Then overflow flag bit is set (WTC: WTOF=1).
- If an interrupt by overflow is permitted (WTC: WTIE=1), an interrupt request is generated upon setting an overflow flag bit.
- Interval time of watch timer is selectable among the following seven choices:

#### • Interval time of watch timer

Sub clock cycle	Interval time
	28/SCLK (31.25 ms)
	29/SCLK (62.5 ms)
	210/SCLK (125 ms)
1/SCLK (122 μs)	2 <sup>11</sup> /SCLK (250 ms)
	212/SCLK (500 ms)
	213/SCLK (1.0 s)
	214/SCLK (2.0 s)

SCLK: Sub clock frequency

Values in parentheses "()" are calculation when operating with 8.192 kHz clock.



Actual interrupt request number of watch timer is as follows:

Interrupt request number: #28 (1CH)

#### Watch timer counter

A 15-bit up counter that uses sub clock (SCLK) as a count clock.

#### • Counter clear circuit

A circuit that clears the watch timer counter.

#### 7. 8/16-bit PPG Timer Outline

The 8/16-bit PPG timer is a 2-channel reload timer module (PPG0 and PPG1) that allows outputting pulses of arbitrary cycle and duty cycle. Combination of the two channels allows selection among the following operations:

- 8-bit PPG output 2-channel independent operation mode
- 16-bit PPG output operation mode
- 8-bit and 8-bit PPG output operation mode

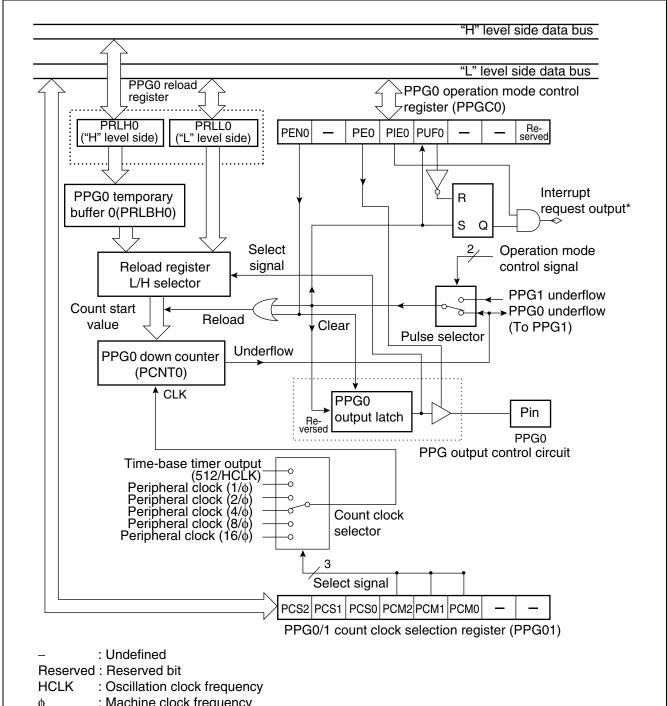
MB90385 series device has two 8/16-bit built-in PPG timers. This section describes functions of PPG0/1. PPG2/3 have the same functions as those of PPG0/1.

#### • Functions of 8/16-bit PPG timer

The 8/16-bit PPG timer is composed of four 8-bit reload register (PRLH0/PRLL0, PRLH1/PRLL1) and two PPG down counters (PCNT0, PCNT1).

- Widths of "H" and "L" in output pulse are specifiable independently. Cycle and duty factor of output pulse is specifiable arbitrarily.
- Count clock is selectable among 6 internal clocks.
- The timer is usable as an interval timer, by generating interrupt requests for each interval.
- The time is usable as a D/A converter, with an external circuit.

### • 8/16-bit PPG timer 0 block diagram

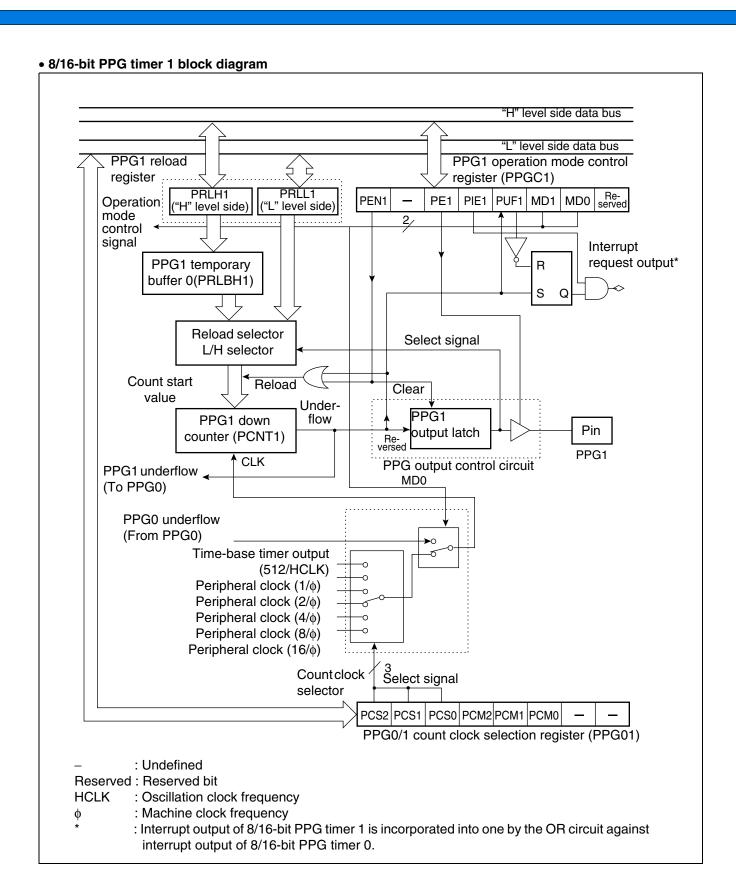


: Machine clock frequency

: Interrupt output of 8/16-bit PPG timer 0 is incorporated into one by the OR circuit against

interrupt output of 8/16-bit PPG timer 1.

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### 8. Delay Interrupt Generation Module Outline

The delay interrupt generation module is a module that generates interrupts for switching tasks. Generation of a hardware interrupt request is performed by software.

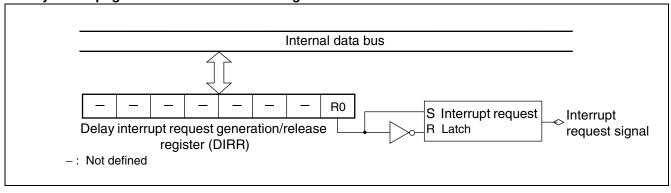
### • Delay interrupt generation module outline

Using the delay interrupt generation module, hardware interrupt request is generated and released by software.

Delay interrupt generation module outline

	Function and control
Cause of interrupt	Set "1" in R0 bit of delay interrupt request generation/release register (DIRR: R0=1), generating an interrupt request.  Set "0" in R0 bit of delay interrupt request generation/release register (DIRR: R0=0), releasing an interrupt request.
Interrupt number	#42 (2A <sub>H</sub> )
Interrupt control	No setting of permission register is provided.
Interrupt flag	Retained in DIRR: R0 bit
El <sup>2</sup> OS	Not ready for expanded intelligent I/O service.





#### Interrupt request latch

A latch that retains settings on delay interrupt request generation/release register (generation or release of delay interrupt request).

#### Delay interrupt request generation/release register (DIRR)

Generates or releases delay interrupt request.

#### • Interrupt number

An interrupt number used in delay interrupt generation module is as follows:

Interrupt number: #42 (2AH)

### 9. DTP/External Interrupt and CAN Wakeup Outline

DTP/external interrupt transfers an interrupt request generated by an external peripheral device or a data transmission request to CPU, generating external interrupt request and activating expanded intelligent I/O service. Input RX of CAN controller is used as external interrupt input.

#### • DTP/external interrupt and CAN wakeup function

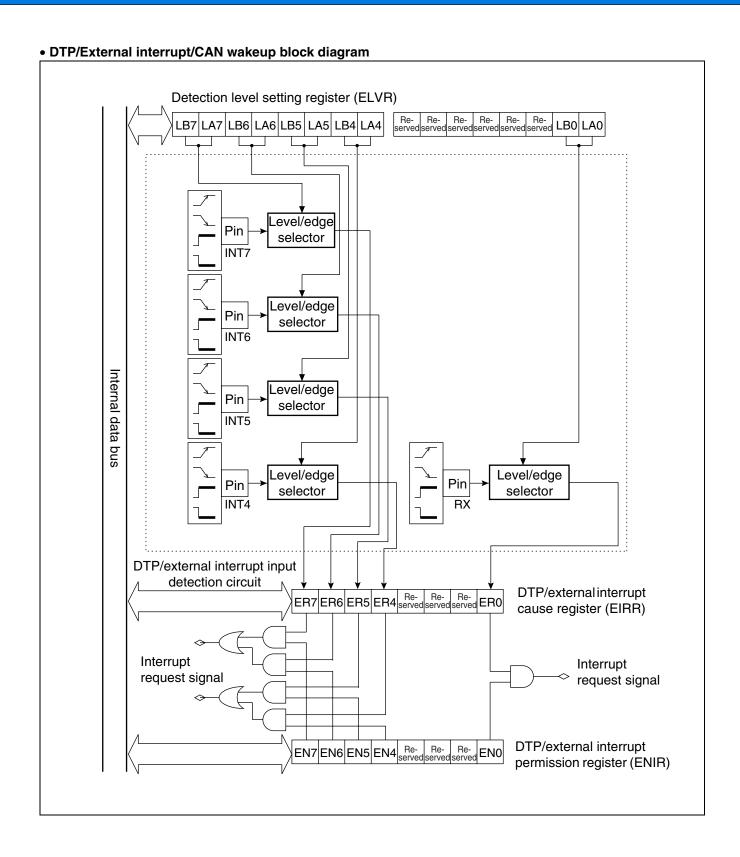
An interrupt request input from external peripheral device to external input pins (INT7 to INT4) and RX pin, just as interrupt request of peripheral device, generates an interrupt request. The interrupt request generates an external interrupt and activates expanded intelligent I/O service (El<sup>2</sup>OS).

If the expanded intelligent I/O service (El<sup>2</sup>OS) has been disabled by interrupt control register (ICR: ISE=0), external interrupt function is enabled and branches to interrupt processing.

If the El<sup>2</sup>OS has been enabled, (ICR: ISE=1), DTP function is enabled and automatic data transmission is performed by El<sup>2</sup>OS. After performing specified number of data transmission processes, the process branches to interrupt processing.

DTP/external interrupt and CAN wakeup outline

	External interrupt DTP function					
Input pin	5 pins (RX, and INT4 to INT7)					
	Specify for each pin with detection level set	ting register (ELVR).				
Interrupt cause	Input of "H" level/"L" level/rising edge/falling edge.	Input of "H" level/ "L" level				
Interrupt number	#15 (0Fн) , #24 (18н) , #27 (1Вн)					
Interrupt control	Enabling or disabling output of interrupt request, using DTP/external interrupt permission register (ENIR).					
Interrupt flag	Retaining interrupt cause with DTP/external	interrupt cause register (EIRR).				
Process selection	Disable El <sup>2</sup> OS (ICR: ISE=0) Enable El <sup>2</sup> OS (ICR: ISE=1)					
Process	Branch to external interrupt process	After automatic data transmission by El <sup>2</sup> OS for specified number of times, branch to interrupt process.				



#### 10. 8/10-bit A/D Converter

The 8/10-bit A/D converter converts an analog input voltage into 8-bit or 10/bit digital value, using the RC-type successive approximation conversion method.

- Input signal is selected among 8 channels of analog input pins.
- · Activation trigger is selected among software trigger, internal timer output, and external trigger.

#### • Functions of 8/10-bit A/D converter

The 8/10-bit A/D converter converts an analog voltage (input voltage) input to analog input pin into an 8-bit or 10-bit digital value (A/D conversion).

The 8/10-bit A/D converter has the following functions:

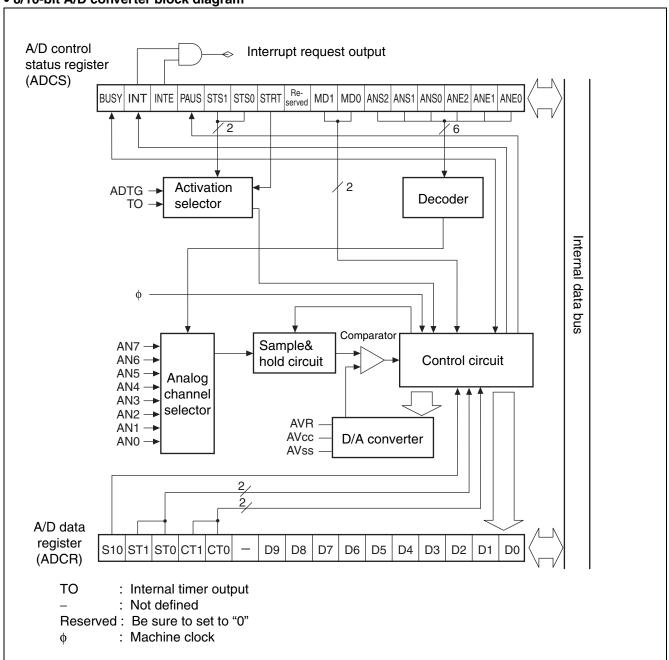
- A/D conversion takes a minimum of 6.12 μs\* for 1 channel, including sampling time. (A/D conversion)
- Sampling of one channel takes a minimum of 2.0 μs\*.
- RC-type successive approximation conversion method, with sample & hold circuit is used for conversion.
- Resolution of either 8 bits or 10 bits is specifiable.
- A maximum of 8 channels of analog input pins are allowed for use.
- Generation of interrupt request is allowed, by storing A/D conversion result in A/D data register.
- Activation of El<sup>2</sup>OS is allowed upon occurrence of an interrupt request. With use of El<sup>2</sup>OS, data loss is avoided even if A/D conversion is performed successively.
- An activation trigger is selectable among software trigger, internal timer output, and external trigger (fall edge).

#### • 8/10-bit A/D converter conversion mode

Conversion mode	Description
Singular conversion mode	The A/D conversion is performed form a start channel to an end channel sequentially. Upon completion of A/D conversion on an end channel, A/D conversion function stops.
Sequential conversion mode	The A/D conversion is performed form a start channel to an end channel sequentially. Upon completion of A/D conversion on an end channel, A/D conversion function resumes from the start channel.
Pausing conversion mode	The A/D conversion is performed by pausing at each channel. Upon completion of A/D conversion on an end channel, A/D conversion and pause functions resume from the start channel.

<sup>\*:</sup> When operating with 16 MHz machine clock

## • 8/10-bit A/D converter block diagram



#### 11. UART Outline

UART is a general-purpose serial data communication interface for synchronous and asynchronous communication using external devices.

- Provided with bi-directional communication function for both clock-synchronous and clock-asynchronous modes.
- Provided with master/slave communication function (multi-processor mode). (Only master side is available.)
- Interrupt request is generated upon completion of reception, completion of transmission and detection of reception error.
- Ready for expanded intelligent service, El<sup>2</sup>OS.

#### **UART functions**

	Description
Data buffer	Full-duplex double buffer
Transmission mode	Clock synchronous (No start/stop bit, no parity bit) Clock asynchronous (start-stop synchronous)
Baud rate	Built-in special-purpose baud-rate generator. Setting is selectable among 8 values. Input of external values is allowed. Use of clock from external timer (16-bit reload timer 0) is allowed.
Data length	7 bits (only asynchronous normal mode) 8 bits
Signaling system	Non Return to Zero (NRZ) system
Reception error detection	Framing error Overrun error Parity error (not detectable in operation mode 1 (multi-processor mode))
Interrupt request	Receive interrupt (reception completed, reception error detected) Transmission interrupt (transmission completed) Ready for expanded intelligent I/O service (EI <sup>2</sup> OS) in both transmission and reception
Master/slave communication function (asynchronous, multi-processor mode)	Communication between 1 (master) and n (slaves) are available (usable as master only).

Note: Start/stop bit is not added upon clock-synchronous transmission. Data only is transmitted.

#### **UART** operation modes

Operation mode		Data I	ength	Synchronization	Stop bit length	
	Operation mode	With parity	Without parity	Synchronization	Stop bit leligtii	
0	Asynchronous mode (normal mode)	7-bit c	7-bit or 8-bit		1- bit or 2-bit *2	
1	Multi processor mode	8+1*1		Asynchronous		
2	Synchronous mode	8	_	Synchronous	No	

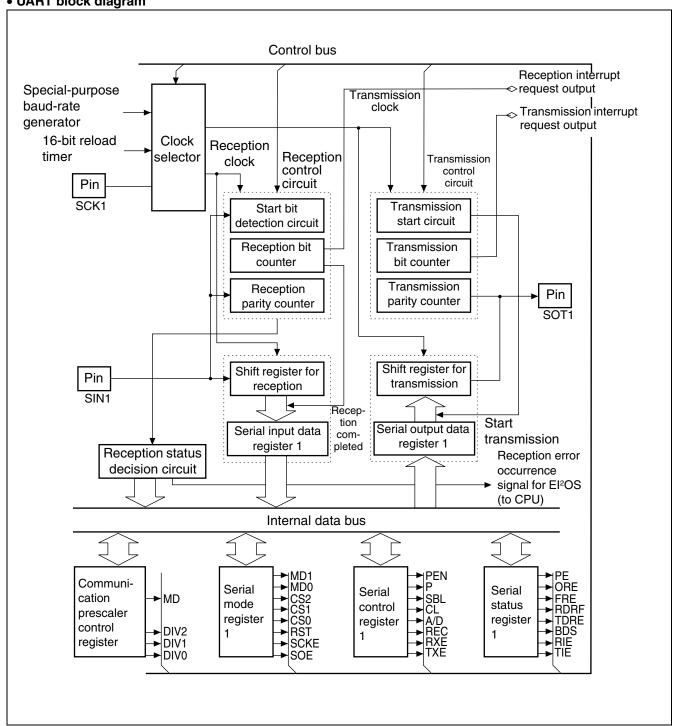
<sup>- :</sup> Disallowed

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<sup>\*1 : &</sup>quot;+1" is an address/data selection bit used for communication control (bit 11 of SCR1 register: A/D).

<sup>\*2 :</sup> Only 1 bit is detected as a stop bit on data reception.





#### 12. CAN Controller

The Controller Area Network (CAN) is a serial communication protocol compliant with CANVer2.0A and Ver2.0B. The protocol allows data transmission and reception in both standard frame format and expanded frame format.

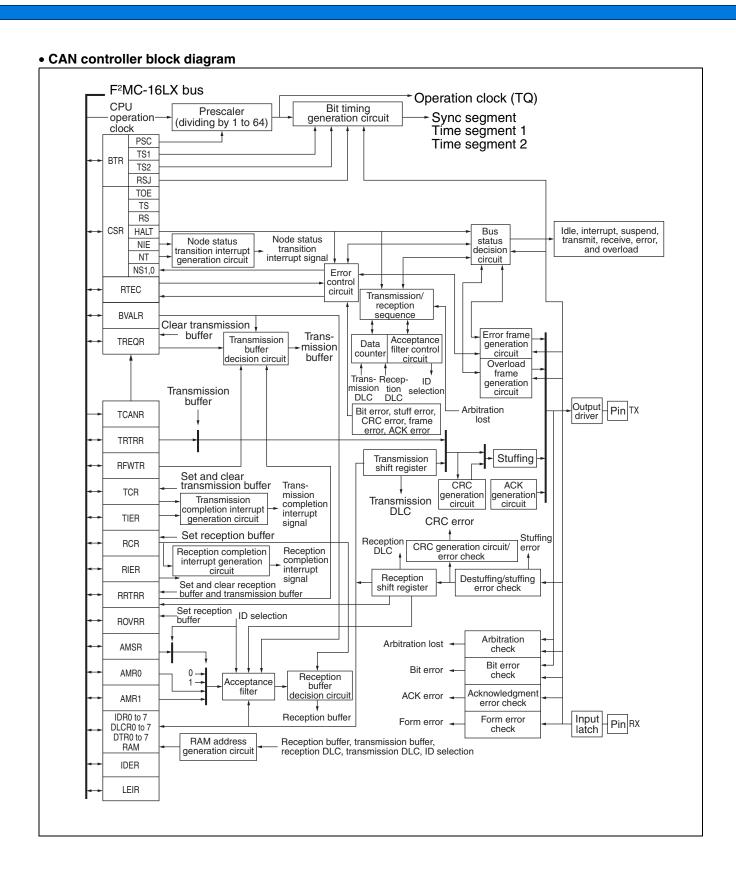
#### Features of CAN controller

- CAN controller format is compliant with CANVer2.0A and Ver2.0B.
- The protocol allows data transmission and reception in standard frame format and expanded frame format.
- Automatic transmission of data frame by remote frame reception is allowed.
- Baud rate ranges from 10 kbps to 1 Mbps (with 16-MHz machine clock).

#### Data transmission baud rate

Machine clock	Baud rate (Max)
16 MHz	1 Mbps
12 MHz	1 Mbps
8 MHz	1 Mbps
4 MHz	500 kbps
2 MHz	250 kbps

- Provided with 8 transmission/reception message buffers.
- Transmission/reception is allowed at ID 11 bit in standard format, and at ID 29 bit in expanded frame format.
- Specifying 0 byte to 8 bytes is allowed in message data.
- Multi-level message buffer configuration is allowed.
- CAN controller has two built-in acceptance masks. Mask settings are independently allowed for the two acceptance masks on reception IDs.
- The two acceptance masks allow reception in standard frame format and expanded frame format.
- For types of masking, all-bit comparison, all-bit masking, and partial masking with acceptance mask register 0/1, are specifiable.



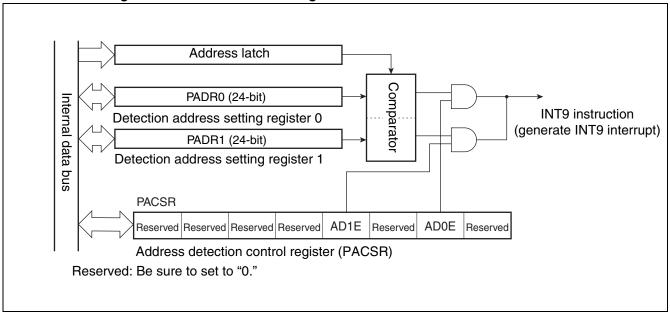
### 13. Address Matching Detection Function Outline

The address matching detection function checks if an address of an instruction to be processed next to a currently-processed instruction is identical with an address specified in the detection address register. If the addresses match with each other, an instruction to be processed next in program is forcibly replaced with INT9 instruction, and process branches to the interrupt process program. Using INT9 interrupt, this function is available for correcting program by batch processing.

#### Address matching detection function outline

- An address of an instruction to be processed next to a currently-processed instruction of the program is always
  retained in an address latch via internal data bus. By the address matching detection function, the address
  value retained in the address latch is always compared with an address specified in detection address setting
  register. If the compared address values match with each other, an instruction to be processed next by CPU
  is forcibly replaced with INT9 instruction, and an interrupt process program is executed.
- Two detection address setting registers are provided (PADR0 and PADR1), and each register is provided with interrupt permission bit. Generation of interrupt, which is caused by address matching between the address retained in address latch and the address specified in address setting register, is permitted and prohibited on a register-by-register basis.



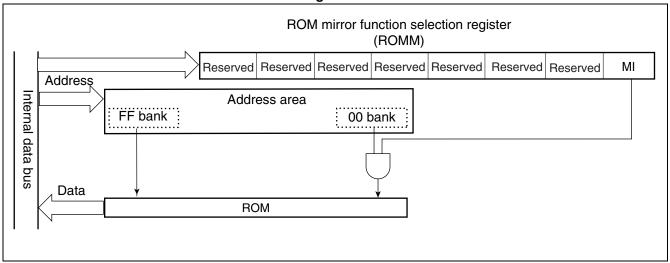


- · Address latch
  - Retains address value output to internal data bus.
- Address detection control register (PACSR)
   Specifies if interrupt is permitted or prohibited when addresses match with each other.
- Detection address setting (PADR0, PADR1)
   Specifies addresses to be compared with values in address latch.

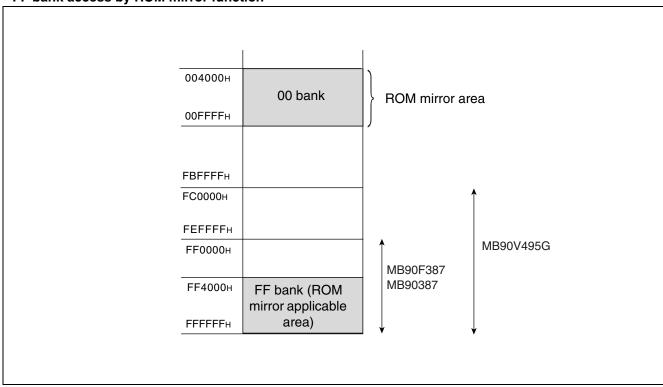
#### 14. ROM Mirror Function Selection Module Outline

The ROM mirror function selection module sets the data in ROM assigned to FF bank so that the data is read by access to 00 bank.

#### • ROM mirror function selection module block diagram



### • FF bank access by ROM mirror function



### 15. 512 Kbit Flash Memory Outline

The following three methods are provided for data writing and deleting on Flash memory:

- 1. Parallel writer
- 2. Serial special-purpose writer
- 3. Writing/deleting by program execution

This section describes "3. Writing/deleting by program execution."

#### • 512 Kbit Flash memory outline

The 512 Kbit Flash memory is allocated on FF<sub>H</sub> bank of CPU memory map. Using the function of Flash memory interface circuit, the memory allows read access and program access from CPU.

Writing/deleting on Flash memory is performed by instruction from CPU via Flash memory interface. Because rewriting is allowed on mounted memory, modifying program and data is performed efficiently.

#### • Features of 512 Kbit Flash memory

- 128 K words x 8 bits/64 K words x 16 bits (16 K + 8 K + 8 K + 32 K) sector configuration
- Automatic program algorithm (Embedded Algorithm : Similar to MBM29LV200.)
- Built-in deletion pause/deletion resume function
- Detection of completed writing/deleting by data polling and toggle bits.
- Detection of completed writing/deleting by CPU interrupt.
- Deletion is allowed on a sector-by-sector basis (sectors are combined freely).
- Number of writing/deleting operations (minimum): 10,000 times
- Sector protection
- Expanded sector protection
- · Temporaly sector unprotection

Note: A function of reading manufacture code and device code is not provided. These codes are not accessible by command either.

### • Flash memory writing/deleting

- Writing and reading data is not allowed simultaneously on the Flash memory.
- Data writing and deleting on the Flash memory is performed by the processes as follows: Make a copy of program on Flash memory onto RAM. Then, execute the program copied on the RAM.

### List of registers and reset values in Flash memory

Flash memory control status register (FMCS) bit 7 6 5 4 3 2 1 0 0 0 0 X 0 0 0 0

× : Undefined

## • Sector configuration

For access from CPU, SA0 to SA3 are allocated in FF bank register.

## • Sector configuration of 512 Kbit Flash memory

Flash memory	CPU address	Writer address*
	FF0000H	70000н
SA0 (32 Kbytes)		
	FF7FFFH	77FFFH
	FF8000H	78000н
SA1 (8 Kbytes)		
	FF9FFFH	79FFFн
	FFA000H	7А000н
SA2 (8 Kbytes)		
	FFBFFFH	7BFFFн
	FFC000H	7С000н
SA3 (16 Kbytes)		
	FFFFFFH	7FFFFH

<sup>\*: &</sup>quot;Writer address" is an address equivalent to CPU address, which is used when data is written on Flash memory, using parallel writer. When writing/deleting data with general-purpose writer, the writer address is used for writing and deleting.

#### **■ ELECTRIC CHARACTERISTICS**

### 1. Absolute Maximum Rating

Dovometov	Cumbal	Rat	ting	Unit	Remarks	
Parameter	Symbol	Min	Max	Unit		
	Vcc	Vss - 0.3	Vss + 6.0	V		
Power supply voltage*1	AVcc	Vss - 0.3	Vss + 6.0	V	$Vcc = AVcc^{*2}$	
	AVR	Vss - 0.3	Vss + 6.0	V	AVcc ≥ AVR*2	
Input voltage*1	Vı	Vss - 0.3	Vss + 6.0	V	*3	
Output voltage*1	Vo	Vss - 0.3	Vss + 6.0	V	*3	
Maximum clamp current	ICLAMP	- 2.0	+ 2.0	mA	*7	
Total maximum clamp current	Σ   ICLAMP	_	20	mA	*7	
"L" level maximum output current	lol1	_	15	mA	Normal output*4	
L level maximum output current	lol2	_	40	mA	High-current output*4	
"L" level average output current	lolav1	_	4	mA	Normal output*5	
L level average output current	lolav2	_	30	mA	High-current output*5	
"L" level maximum total output current	Σ <b>l</b> OL1	_	125	mA	Normal output	
L level maximum total output current	Σlol2	_	160	mA	High-current output	
"L" level average total output current	Σ <b>I</b> OLAV1	_	40	mA	Normal output*6	
L level average total output current	$\Sigma$ lolav2	_	40	mA	High-current output*6	
"H" level maximum output current	<b>І</b> он1	_	-15	mA	Normal output*4	
n levermaximum output current	10н2	_	-40	mA	High-current output*4	
"H" level average output current	lohav1	_	-4	mA	Normal output*5	
Tri level average output current	lohav2	_	-30	mA	High-current output*5	
"H" level maximum total output current	$\Sigma$ lo $_{1}$	_	-125	mA	Normal output	
i i ievermaximum totai output current	$\Sigma$ loh2	_	-160	mA	High-current output	
"H" level average total output current	$\Sigma$ lohav1	_	-40	mA	Normal output*6	
Tri level average total output current	$\Sigma$ lohav2		-40	mA	High-current output*6	
Power consumption	Po		245	mW		
Operating temperature	TA	-40	+105	°C		
Storage temperature	Tstg	-55	+150	°C		

<sup>\*1 :</sup> The parameter is based on  $V_{SS} = AV_{SS} = 0.0 \text{ V}$ .

(Continued)

<sup>\*2 :</sup> AVcc and AVR should not exceed Vcc.

<sup>\*3:</sup> V<sub>I</sub> and V<sub>O</sub> should not exceed Vcc + 0.3 V. However if the maximum current to/from an input is limited by some means with external components, the I<sub>CLAMP</sub> rating supersedes the V<sub>I</sub> rating.

<sup>\*4 :</sup> A peak value of an applicable one pin is specified as a maximum output current.

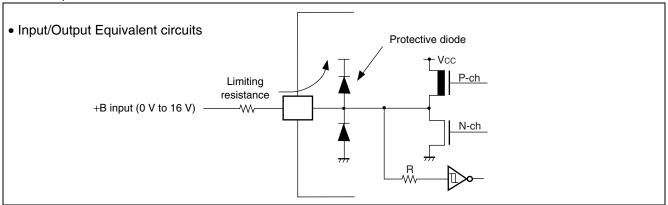
<sup>\*5 :</sup> An average current value of an applicable one pin within 100 ms is specified as an average output current. (Average value is found by multiplying operating current by operating rate.)

<sup>\*6 :</sup> An average current value of all pins within 100 ms is specified as an average total output current. (Average value is found by multiplying operating current by operating rate.)

#### (Continued)

- \*7: Applicable to pins: P10 to P17, P20 to P27, P30 to P33, P35\*, P36\*, P37, P40 to P44, P50 to P57

  \*: P35 and P36 are MB90387S and MB90F387S only.
  - Use within recommended operating conditions.
  - Use at DC voltage (current).
  - The +B signal should always be applied a limiting resistance placed between the +B signal and the microcontroller.
  - The value of the limiting resistance should be set so that when the +B signal is applied the input current to the microcontroller pin does not exceed rated values, either instantaneously or for prolonged periods.
  - Note that when the microcontroller drive current is low, such as in the power saving modes, the +B input potential may pass through the protective diode and increase the potential at the Vcc pin, and this may affect other devices.
  - Note that if a +B signal is input when the microcontroller power supply is off (not fixed at 0 V), the power supply is provided from the pins, so that incomplete operation may result.
  - Note that if the +B input is applied during power-on, the power supply is provided from the pins and the resulting supply voltage may not be sufficient to operate the power-on reset.
  - Care must be taken not to leave the +B input pin open.
  - Note that analog system input/output pins other than the A/D input pins (LCD drive pins, comparator input pins, etc.) cannot accept +B signal input.
  - Sample recommended circuits:



WARNING: Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

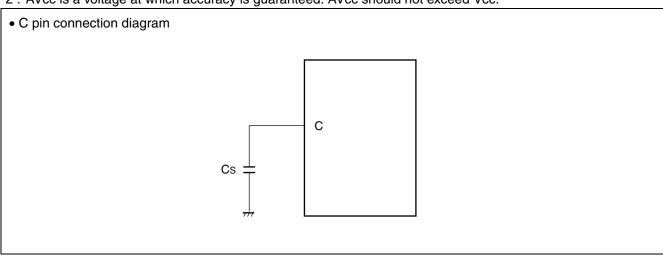
## 2. Recommended Operating Conditions

(Vss = AVss = 0.0V)

Parameter	Symbol	Value			Unit	Remarks	
Parameter	Syllibol	Min	Тур	Max	Oilit	Hemarks	
		3.5	5.0	5.5	V	Under normal operation	
Power supply voltage	Vcc	3.0	_	5.5	V	Retain status of stop operation	
	AVcc	4.0		5.5	V	*2	
Smoothing capacitor	Cs	0.1	_	1.0	μF	*1	
Operating temperature	Та	-40		+105	°C		

<sup>\*1 :</sup> Use a ceramic capacitor, or a capacitor of similar frequency characteristics. On the Vcc pin, use a bypass capacitor that has a larger capacity than that of Cs.
Refer to the following figure for connection of smoothing capacitor Cs.

\*2 : AVcc is a voltage at which accuracy is guaranteed. AVcc should not exceed Vcc.



WARNING: The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated within these ranges.

Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure. No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their representatives beforehand.

## 3. DC Characteristics

(Vcc = 5.0 V $\pm$ 10%, Vss = AVss = 0.0 V, T<sub>A</sub> = -40 °C to +105 °C)

Parame-	Sym-	Pin name	Conditions	E10%, VSS	Value	Unit	Remarks	
ter	bol		Conditions	Min	Тур	Max	Unit	nemarks
input   pin		hysteresis input	_	0.8 Vcc	_	Vcc + 0.3	V	
voltage	Vінм	MD input pin	_	Vcc - 0.3		Vcc + 0.3	V	
"L" level input voltage	VILS	CMOS hysteresis input pin	_	Vss - 0.3	l	0.2 Vcc	٧	
voltage	VILM	MD input pin	_	Vss - 0.3	1	Vss + 0.3	V	
"H" level output	Vон1	Pins other than P14 to P17	Vcc = 4.5 V, Io <sub>H</sub> = -4.0 mA	Vcc - 0.5	1	_	٧	
voltage	V <sub>OH2</sub>	P14 to P17	Vcc = 4.5 V, Io <sub>H</sub> = -14.0 mA	Vcc - 0.5	_	_	V	
"L" level	V <sub>OL1</sub>	Pins other than P14 to P17	Vcc = 4.5 V, lo <sub>L</sub> = 4.0 mA	_	_	0.4	٧	
output voltage V <sub>OL2</sub> P14 to P17		P14 to P17	Vcc = 4.5 V, lo <sub>L</sub> = 20.0 mA	_	_	0.4	٧	
Input leak current	Iı∟	All input pins	Vcc = 5.5 V, Vss < Vı < Vcc	<b>-</b> 5	_	+5	μΑ	
	Icc	Vcc = 5.0 V, Internally operating at 16 MHz, normal operation.	_	25	30	mA		
		Vcc = 5.0 V, Internally operating at 16 MHz, writing on Flash memory.	_	45	50	mA	MB90F387/S	
Power supply current*		Vcc	Vcc = 5.0 V, Internally operating at 16 MHz, deleting on Flash memory.		45	50	mA	MB90F387/S
	Iccs		Vcc = 5.0 V, Internally operating at 16 MHz, sleeping.	_	8	12	mA	
			Vcc = 5.0 V, Internally operating at		0.75	1.0		MB90F387/S
	Істѕ	Істѕ		2 MHz, transition from main clock mode, in time-base timer mode.	_	0.2	0.35	mA

(Continued)

(Continued)

 $(Vcc = 5.0 V \pm 10\%, Vss = AVss = 0.0 V, T_A = -40 °C to +105 °C)$ 

Parame-	Sym-	Pin name	Conditions		Rating		Unit	Remarks	
ter	bol	Fili liaille	Conditions	Min	Тур	Max	Oilit		
	Iccl		Vcc = 5.0 V, Internally operating at 8 kHz, subclock oper-	_	0.3	1.2	mA	MB90F387/S	
	ICCL		ation, $T_A = +25^{\circ}C$	_	40	100	μА	MB90387/S	
Power supply current*	Iccls	Vcc		10	30	μΑ			
	Ісст		Vcc = 5.0 V, Internally operating at 8 kHz, watch mode, T <sub>A</sub> = +25°C	_	8	25	μА		
	Іссн		Stopping, $T_A = +25^{\circ}C$		5	20	μА		
Input capacity	Cin	Other than AVcc, AVss, AVR, C, Vcc, Vss	_	_	5	15	pF		
Pull-up resistor	Rup	RST	_	25	50	100	kΩ		
Pull-down resistor	RDOWN	MD2	_	25	50	100	kΩ	Flash product is not provided with pull-down resistor.	

<sup>\*:</sup> Test conditions of power supply current are based on a device using external clock.

#### 4. AC Characteristics

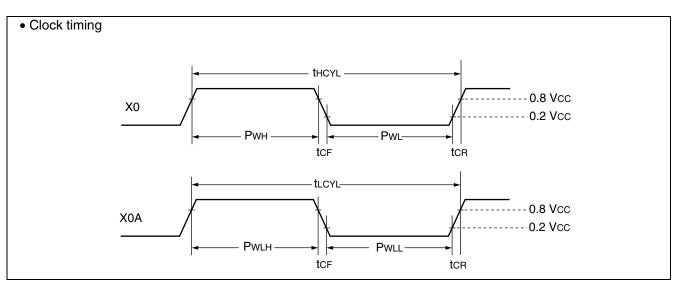
### (1) Clock timing

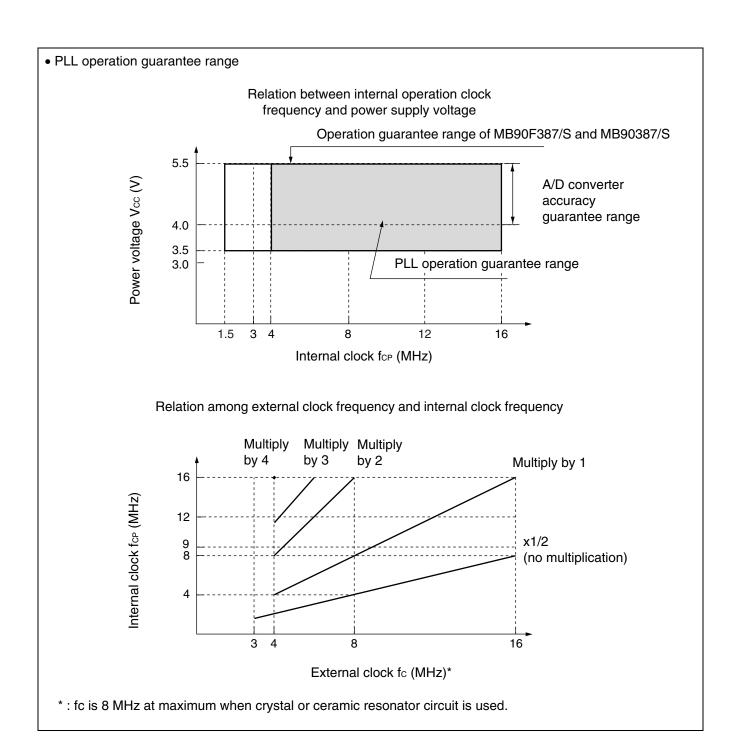
 $(Vcc = 5.0 V\pm 10\%, Vss = AVss = 0.0 V, T_A = -40 °C to +105 °C)$ 

Doromotor	Symbol	mbol Pin name		Value			Remarks	
Parameter	Symbol	Pin name	Min	Тур	Max	Unit	nemarks	
			3	_	8	MHz	When crystal or ceramic resonator is used*2	
			3	_	16	MHz	External clock input*1, *2	
	fc	X0, X1	4	_	16	MHz	PLL Multiply by 1 *2	
Clock frequency			4	_	8	MHz	PLL Multiply by 2 *2	
			4	_	5.33	MHz	PLL Multiply by 3 *2	
			4	_	4	MHz	PLL Multiply by 4 *2	
	fcL	X0A, X1A	_	32.768	_	kHz		
Clock avalo timo	<b>t</b> HCYL	X0, X1	125	_	333	ns		
Clock cycle time	tLCYL	X0A, X1A	_	30.5		μs		
Input clock pulse width	Pwh, PwL	X0	10	_	_	ns	Set duty factor at 30% to 70% as a guideline.	
	Pwlh,Pwll	X0A	_	15.2	_	μs		
Input clock rise time and fall time	tcn, tcf	X0	_	_	5	ns	When external clock is used	
Internal operation clock	<b>f</b> cP	_	1.5	_	16	MHz	When main clock is used	
frequency	fLCP	_	_	8.192	_	kHz	When sub clock is used	
Internal operation clock cycle	tcp	_	62.5	_	666	ns	When main clock is used	
time	tLCP			122.1	_	μs	When sub clock is used	

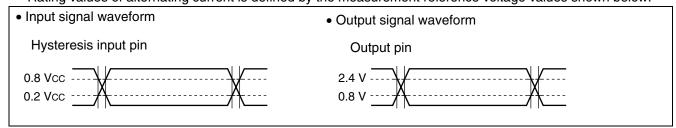
<sup>\*1 :</sup> Internal operation clock frequency should not exceed 16 MHz.

<sup>\*2:</sup> When selecting the PLL clock, the range of clock frequency is limited. Use this product within range as mentioned in "Relation among external clock frequency and internal clock frequency".





Rating values of alternating current is defined by the measurement reference voltage values shown below:

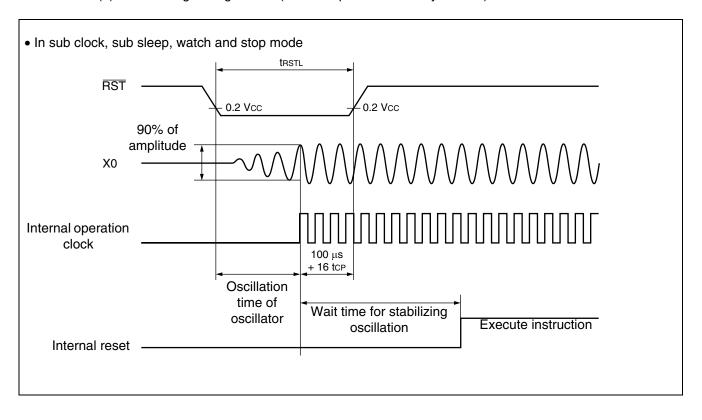


(2) Reset input timing

Parameter	Symbol Pin		Value	Unit	Remarks		
Parameter	Symbol	name	Min	Max	Onn	nemarks	
		RST	16 tcp*3		ns	Normal operation	
Reset input time	<b>t</b> RSTL		Oscillation time of oscillator*1 + 100 μs + 16 tcp*3	l	l	In sub clock*2, sub sleep*2, watch*2 and stop mode	
			100		μs	In timebase timer	

<sup>\*1 :</sup> Oscillation time of oscillator is time that the amplitude reached the 90%. In the crystal oscillator, the oscillation time is between several ms to tens of ms. In ceramic oscillator, the oscillation time is between hundreds of µs to several ms. In the external clock, the oscillation time is 0 ms.

- \*2: Except for MB90F387S and MB90387S.
- \*3 : Refer to "(1) Clock timing" ratings for tcp (internal operation clock cycle time).



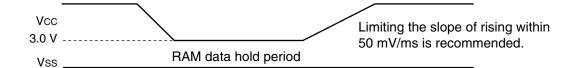
#### (3) Power-on reset

 $(Vcc = 5.0 V \pm 10\%, Vss = AVss = 0.0 V, T_A = -40 °C to +105 °C)$ 

Parameter	Symbol	Pin name	Conditions	Va	lue	Unit	Remarks	
raiailletei	Symbol	Filitialile	Conditions	Min	Max	Oilit		
Power supply rise time	t⊓	Vcc		0.05	30	ms		
Power supply shutdown time	toff	Vcc	_	1		ms	Waiting time until power-on	



Sudden change of power supply voltage may activate the power-on reset function. When changing power supply voltages during operation, raise the power smoothly by suppressing variation of voltages as shown below. When raising the power, do not use PLL clock. However, if voltage drop is 1V/s or less, use of PLL clock is allowed during operation.



## (4) UART timing

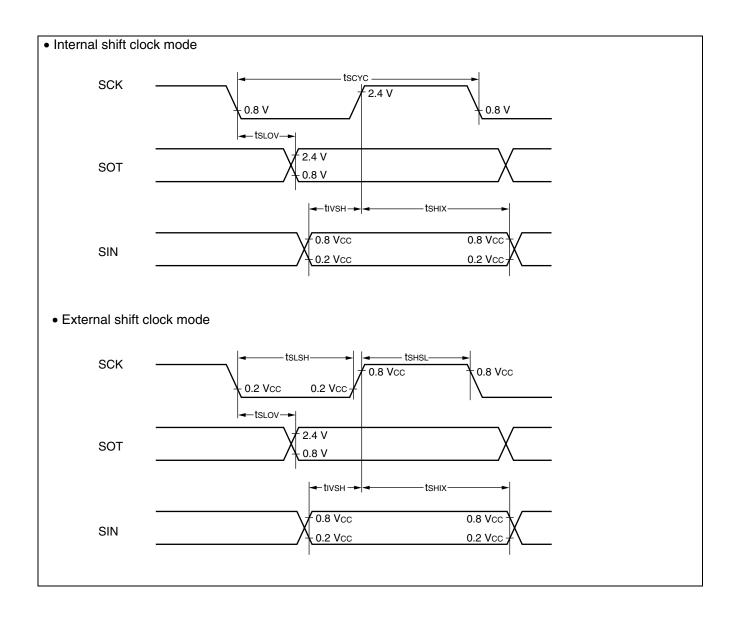
 $(Vcc = 4.5 \text{ V to } 5.5 \text{ V}, Vss = 0.0 \text{ V}, T_A = -40 ^{\circ}\text{C to } +105 ^{\circ}\text{C})$ 

Parameter	Symbol Pin name		Conditions	Value		Unit	Remarks
Parameter			Conditions	Min Max		Oill	nemarks
Serial clock cycle time	tscyc	SCK1		4 tcp*		ns	
$SCK \downarrow \to SOT$ delay time	tslov	SCK1, SOT1	Internal shift clock	-80	+80	ns	
Valid SIN → SCK ↑	tıvsн	SCK1, SIN1	mode output pin is : CL = 80 pF+1TTL.	100	_	ns	
SCK $\uparrow \rightarrow$ valid SIN hold time	tsнıх	SCK1, SIN1		60	_	ns	
Serial clock "H" pulse width	<b>t</b> shsl	SCK1		2 tcp*		ns	
Serial clock "L" pulse width	<b>t</b> slsh	SCK1		2 tcp*		ns	
$SCK \downarrow \to SOT$ delay time	tsLov	SCK1, SOT1	External shift clock mode output pin is :		150	ns	
Valid SIN → SCK ↑	tıvsн	SCK1, SIN1	CL = 80 pF+1TTL.	60	_	ns	
SCK $\uparrow \rightarrow$ valid SIN hold time	tsнıх	SCK1, SIN1		60	_	ns	

<sup>\* :</sup> Refer to "(1) Clock timing" ratings for tcp (internal operation clock cycle time).

Notes: • AC Characteristics in CLK synchronous mode.

 $\bullet$   $C_{L}$  is a load capacitance value on pins for testing.

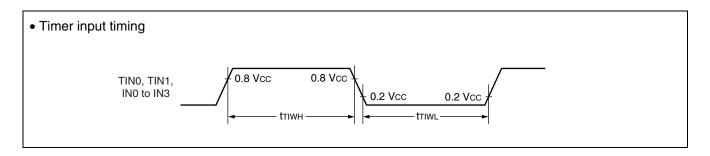


### (5) Timer input timing

 $(Vcc = 4.5 V to 5.5 V, Vss = 0.0 V, T_A = -40 °C to +105 °C)$ 

Parameter	Symbol	Pin name	Conditions	Val	ue	Unit	Remarks
Farameter	Syllibol	riii iiaiiie	Conditions	Min	Max	Oilit	nemarks
Input pulse width	<b>t</b> тıwн	TIN0, TIN1		4 t <sub>CP</sub> *	_	ns	
input puise width	t⊤ıw∟	IN0 to IN3		<b>4 (</b> CP			

<sup>\* :</sup> Refer to "(1) Clock timing" ratings for tcp (internal operation clock cycle time).

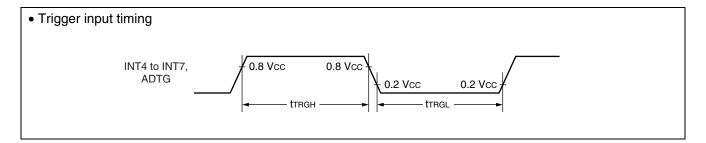


## (6) Trigger input timing

 $(Vcc = 4.5 \text{ V to } 5.5 \text{ V}, Vss = 0.0 \text{ V}, T_A = -40 ^{\circ}\text{C to } +105 ^{\circ}\text{C})$ 

Parameter	Symbol	Pin name	Conditions	Value		Unit	Remarks
Farameter	Syllibol	Fili Hallie	Conditions	Min	Max	Oill	nemarks
Input pulse width	tтrgн tтrgl	INT4 to INT7, ADTG	_	5 tcp*	_	ns	

<sup>\*:</sup> Refer to "(1) Clock timing" ratings for tcp (internal operation clock cycle time).



## 5. A/D converter

(Vcc = AVcc = 4.0 V to 5.5 V, Vss = AVss = 0.0 V, 3.0 V  $\leq$  AVR - AVss, TA = -40 °C to +105 °C)

		Pin	•	Value		-	Personks	
Parameter	Symbol	name	Min	Тур	Max	Unit	Remarks	
Resolution	_		_	_	10	bit		
Total error	_	_	_	_	± 3.0	LSB		
Nonlinear error	_	_	_	_	± 2.5	LSB		
Differential linear error	_	_	_	_	± 1.9	LSB		
Zero transition voltage	Vот	AN0 to AN7	AVss – 1.5 LSB	AVss + 0.5 LSB	AVss + 2.5 LSB	V	1 LSB = (AVR -	
Full-scale transition voltage	V <sub>FST</sub>	AN0 to AN7	AVR – 3.5 LSB	AVR – 1.5 LSB	AVR + 0.5 LSB	V	AVss) /1024	
Compare time			66 tcp*1	_	_	ns	With 16 MHz machine clock 5.5 V ≥ AVcc ≥ 4.5 V	
Compare time	_		88 tcp*1	_	_	ns	With 16 MHz machine clock 4.5 V > AVcc ≥ 4.0 V	
Sampling time	_		32 tcp*1	_	_	ns	With 16 MHz machine clock 5.5 V ≥ AVcc ≥ 4.5 V	
Sampling time		_	128 tcp *1	_	_	ns	With 16 MHz machine clock 4.5 V > AVcc ≥ 4.0 V	
Analog port input current	lain	AN0 to AN7		_	10	μΑ		
Analog input voltage	Vain	AN0 to AN7	AVss	_	AVR	V		
Reference voltage	_	AVR	AVss + 2.7	_	AVcc	V		
Dower oundly ourrent	lΑ	AVcc	_	3.5	7.5	mA		
Power supply current	Іан	AVcc	_	_	5	μΑ	*2	
Reference voltage	IR	AVR	_	165	250	μΑ		
supplying current	IRH	AVR	_	_	5	μΑ	*2	
Variation among channels		AN0 to AN7	_	_	4	LSB		

<sup>\*1 :</sup> Refer to "4. AC Characteristics (1) Clock timing".

<sup>\*2 :</sup> If A/D converter is not operating, a current when CPU is stopped is applicable (Vcc=AVcc=AVR=5.0 V).

#### 6. Definition of A/D Converter Terms

Resolution : Analog variation that is recognized by an A/D converter.

Linear error : Deviation between a line across zero-transition line ("00 0000 00 0 0" ←→"00 0000 0001")

and full-scale transition line ("11 1111 11 10"  $\leftarrow \rightarrow$  "11 1111 1111") and actual conversion

characteristics.

Differential linear

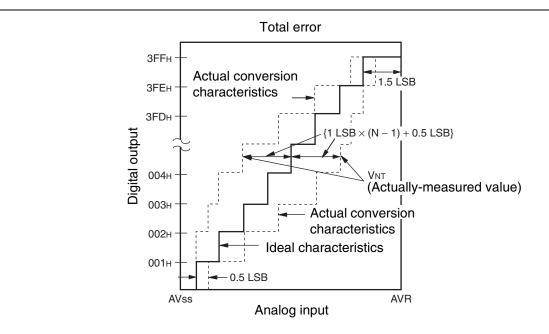
error

: Deviation of input voltage, which is required for changing output code by 1 LSB, from an

ideal value.

Total error : Difference between an actual value and an ideal value. A total error includes zero transition

error, full-scale transition error, and linear error.



Total error of digital output "N" = 
$$V_{NT} - \{1 \text{ LSB} \times (N-1) + 0.5 \text{ LSB}\}\$$
 [LSB]

$$1 LSB = (Ideal value) \frac{AVR - AVss}{1024} [V]$$

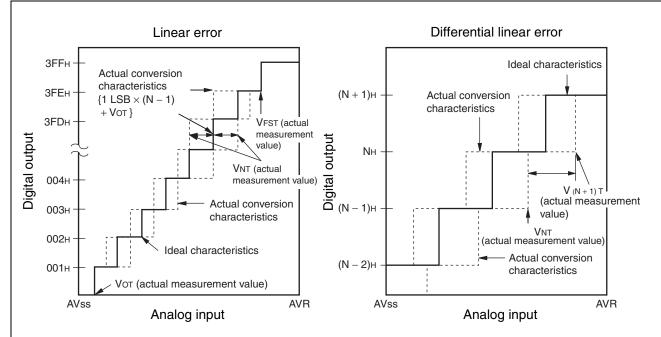
Vot (Ideal value) = AVss + 0.5 LSB [V]

 $V_{FST}$  (Ideal value) = AVR - 1.5 LSB [V]

 $V_{\text{NT}}$  : A voltage at which digital output transits from (N-1) $\!_{\text{H}}$  to  $N_{\text{H}}.$ 

(Continued)

## (Continued)



$$Linear\ error\ of\ digital\ output\ N = \frac{V_{NT} - \{1\ LSB \times\ (N-1)\ + Vor\}}{1\ LSB} [LSB]$$

$$\label{eq:differential linear error of digital output N = } \frac{V \left(N + 1\right) T - V_{NT}}{1 \text{ LSB}} - 1 \text{LSB} \text{ [LSB]}$$

$$1 LSB = \frac{V_{FST} - V_{OT}}{1022}[V]$$

 $V_{\text{OT}}$ : Voltage at which digital output transits from "000H" to "001H."  $V_{\text{FST}}$ : Voltage at which digital output transits from "3FEH" to "3FFH."

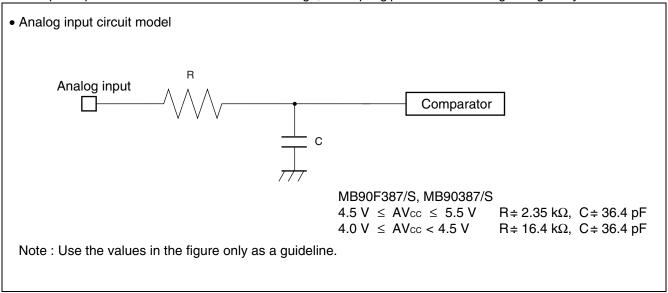
### 7. Notes on A/D Converter Section

Use the device with external circuits of the following output impedance for analog inputs:

Recommended output impedance of external circuits are: Approx. 3.9 k $\Omega$  or lower (4.5 V  $\leq$  AVcc  $\leq$  5.5 V) (sampling period=2.00  $\mu$ s at 16 MHz machine clock), Approx. 11 k $\Omega$  or lower (4.0 V  $\leq$  AVcc < 4.5 V) (sampling period=8.0  $\mu$ s at 16 MHz machine clock).

If an external capacitor is used, in consideration of the effect by tap capacitance caused by external capacitors and on-chip capacitors, capacitance of the external one is recommended to be several thousand times as high as internal capacitor.

If output impedance of an external circuit is too high, a sampling period for an analog voltage may be insufficient.



### About errors

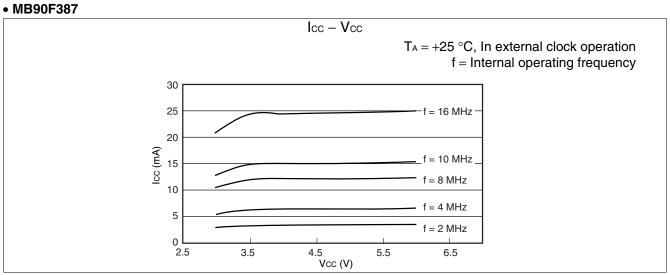
As [AVR-AVss] become smaller, values of relative errors grow larger.

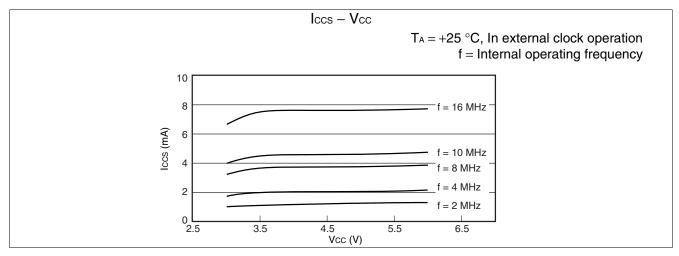
### 8. Flash Memory Program/Erase Characteristics

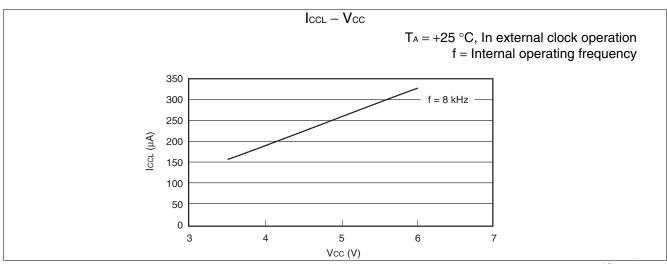
Parameter	Conditions	Value			Unit	Remarks
		Min	Тур	Max	Oilit	nemarks
Sector erase time	T <sub>A</sub> = + 25 °C V <sub>CC</sub> = 5.0 V		1	15	s	Excludes 00H programming prior to erasure
Chip erase time			4	_	s	Excludes 00H programming prior to erasure
Word (16-bit width) programming time		_	16	3,600	μs	Except for the over head time of the system
Program/Erase cycle	_	10,000	_	_	cycle	
Flash Data Retention Time	Average T <sub>A</sub> = + 85 °C	20	_		Year	*

 $<sup>^{\</sup>star}$ : This value comes from the technology qualification (using Arrhenius equation to translate high temperature measurements into normalized value at + 85  $^{\circ}$ C).

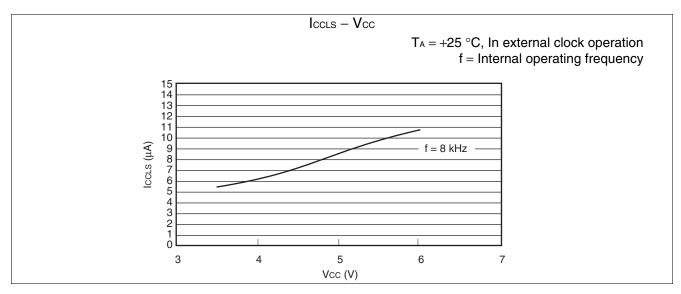
### **■ EXAMPLE CHARACTERISTICS**

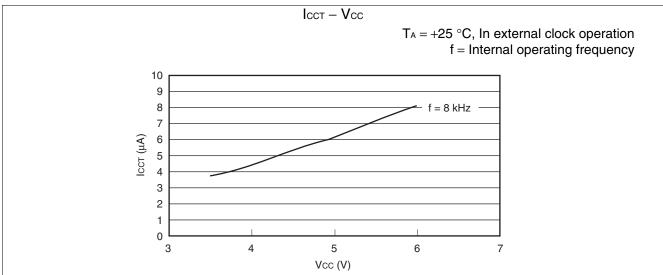


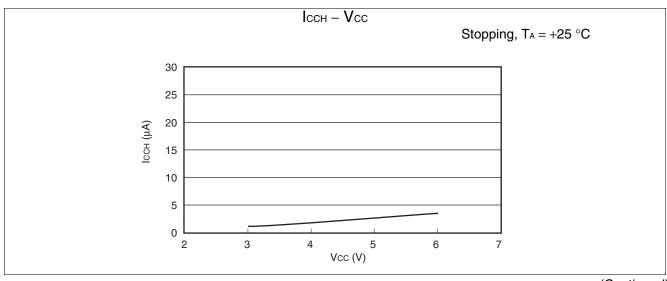




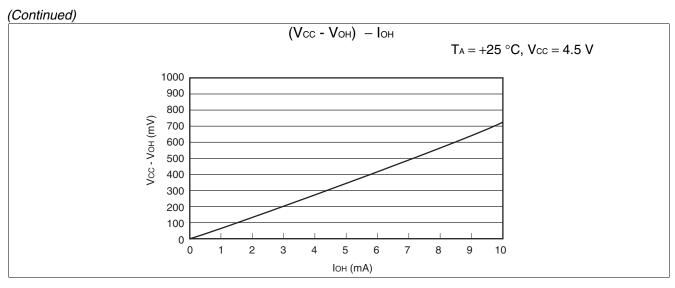
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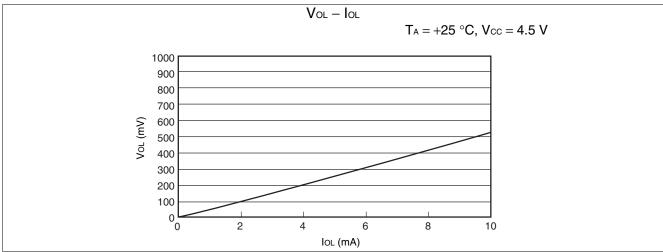


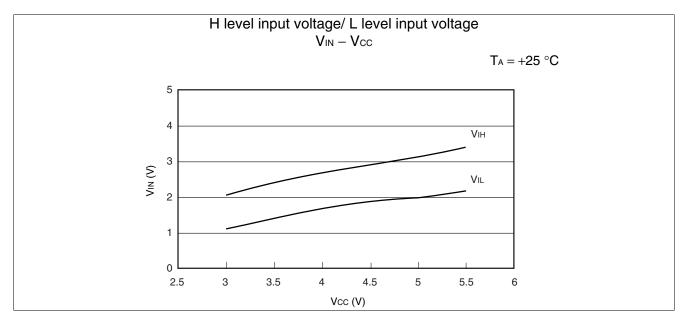




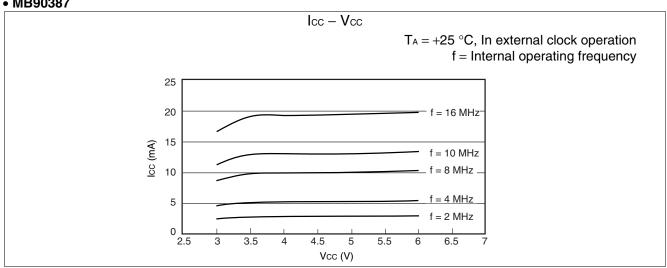
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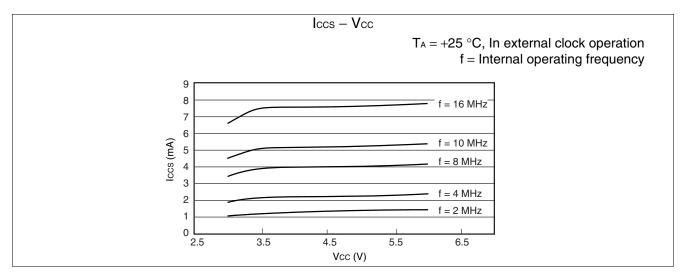


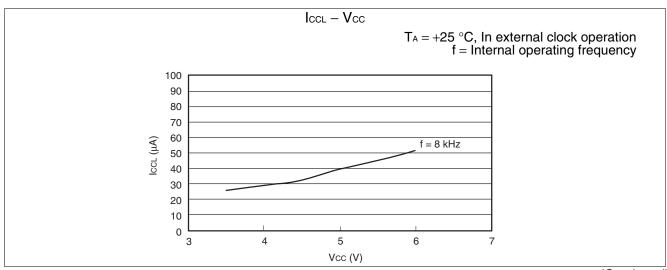


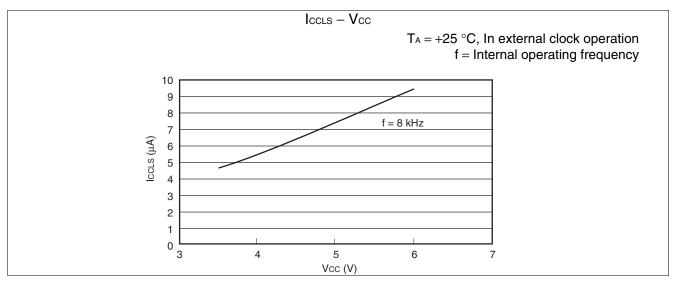


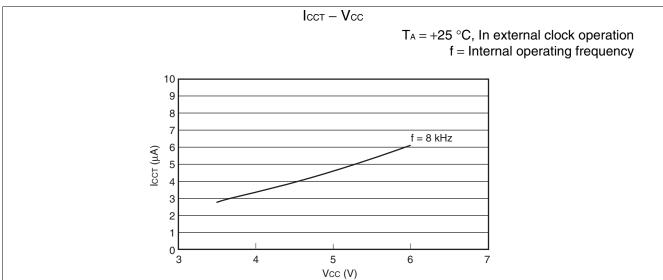
### • MB90387

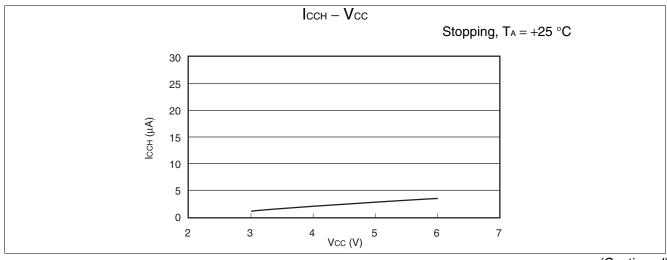




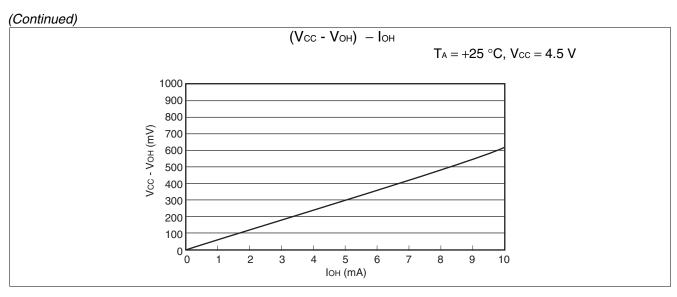


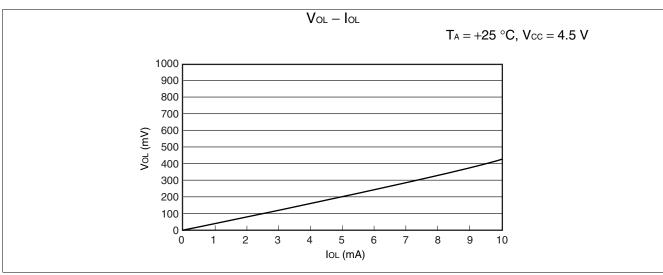


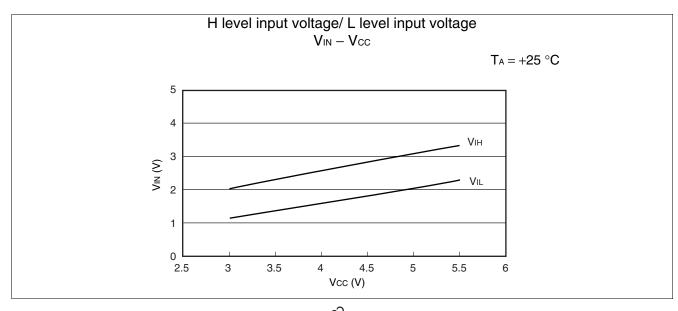




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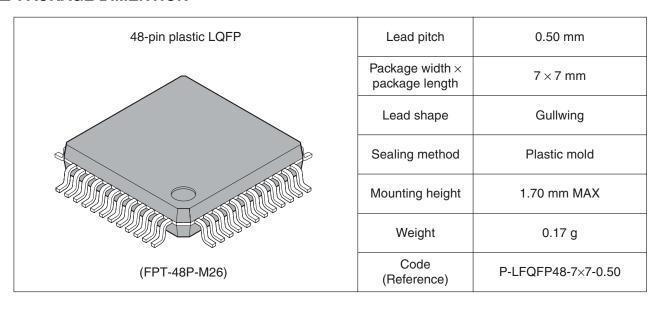


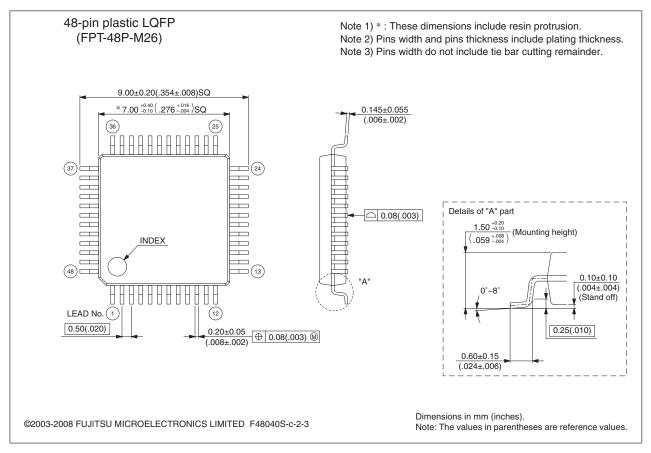


### **■ ORDERING INFORMATION**

Part number	Package	Remarks
MB90F387PMT MB90387PMT MB90F387SPMT MB90387SPMT	48-pin plastic LQFP (FPT-48P-M26)	

### **■ PACKAGE DIMENTION**



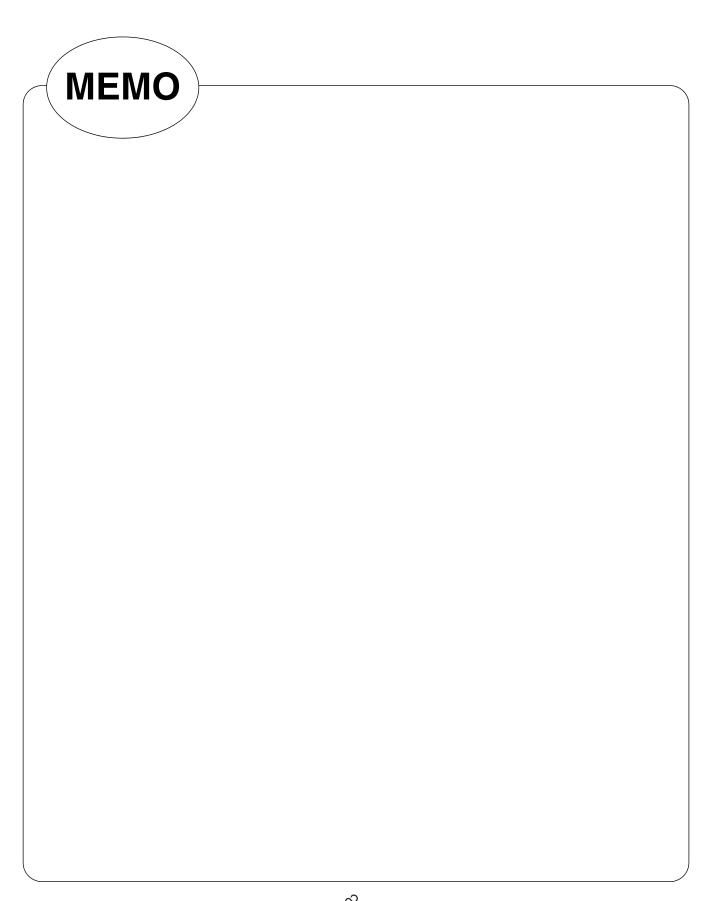


Please confirm the latest Package dimension by following URL. http://edevice.fujitsu.com/package/en-search/

### ■ MAIN CHANGES IN THIS EDITION

Page	Section	Change Results
4	■ PRODUCT LINEUP	Changed the number of channel of 8/16 bit PPG timer. or one 16-bit channel $\rightarrow$ or two 16-bit channels
13	■ BLOCK DIAGRAM	Changed the direction of arrow of TIN0, TIN1 signals of 16-bit reload timer. right arrow (output) $\rightarrow$ left arrow (input)
67	■ ELECTRIC CHARACTERISTICS 4. AC Characteristics (4) UART timing	Changed the value of Serial clock. Serial clock "H" pulse width : 4tcp→2tcp Serial clock "L" pulse width : 4tcp→2tcp

The vertical lines marked in the left side of the page show the changes.



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